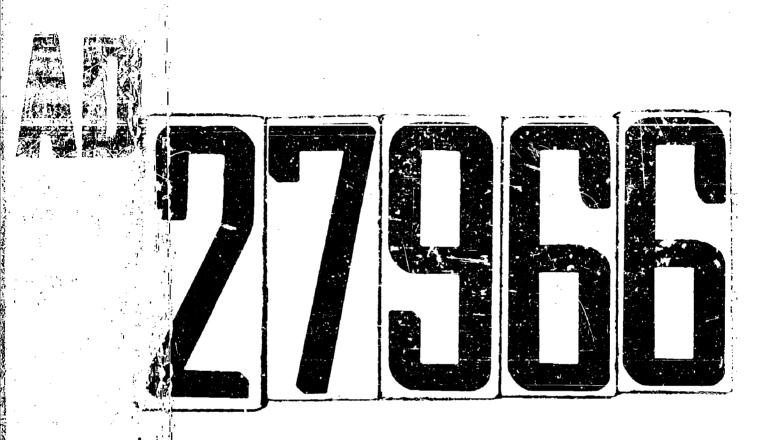
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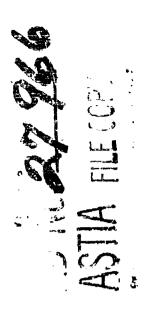
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U. S. DEPARTMENT OF COMMERCE NATIONAL BUREAU OF STANDARDS

MANUFACTURING COST DETERMINATION

VOLUME 5

by

Mead Carney & Company, Inc. International Building, Rockefeller Center, New York 20, N. Y.

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PREFACE

This volume presents a preliminary survey of cost factors applicable to electronic equipment of stacked wafer modular desing as produced by mechanized or semi-mechanized techniques. Specifically, the volume is a reproduction of a report submitted to the National Bureau of Standards by Mead Carney and Co., Inc., management consultants. This manufacturing cost determination, although necessarily tentative, is based upon the best data on PROJECT TINKERTOY available at his time and is issued at the particular request of the Navy Bureau of Aeronautics, sponsors of the program.

Since the receipt of the Mead Carney Company's report, the Navy has announced that the name, PROJECT TINKERTOI, is no longer to be used to describe the program. Rather, modular design of electronics and mechanized production of electronics are to be used to designate the respective phases of the program. However, in order to make this volume immediately available to the electronics industry, it is being duplicated directly from the original manuscript. Consequently the name PROJECT TINKERTOY appears in some instances.

PROJECT TINKERTOY

MANUFACTURING COST DETERMINATION

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I INTRODUCTION

I - INTRODUCTION

Description of Project Tinkertoy

Project Tinkertoy is the code name of a new system for manufacturing electronic circuits, which is illustrated on Exhibit I opposite. It was conceived and developed by the National Bureau of Standards and sponsored by the U.S. Navy Bureau of Aeronautics.

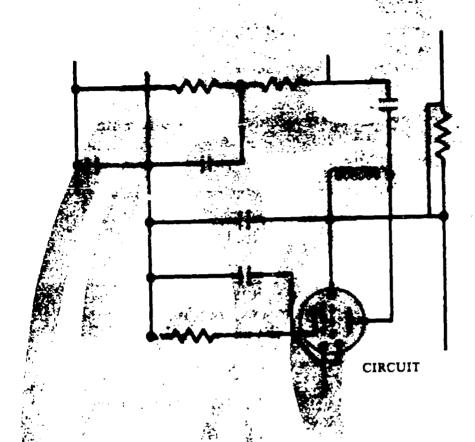
The unique basic component of Project Tinkertoy is the ceramic wafer. It provides the base onto which the major portion of the circuitry is printed. This silver paint base circuit is affixed by heat, which is a principal reason for the use of ceramics. The wafer rigidly supports, and has attached to it, a variety of electronic elements, such as resistors, capacitors, potentiometers, tube sockets, and tubes.

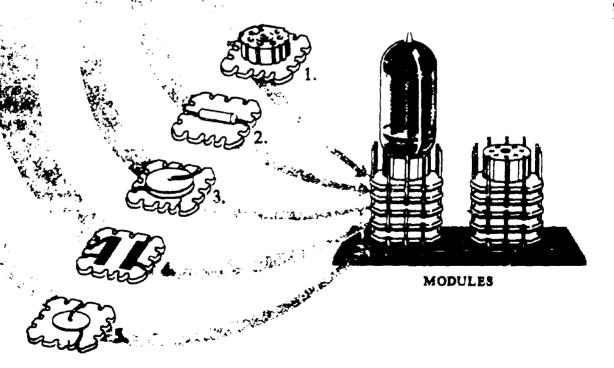
Tiers of up to six such wafers, each appropriately printed and electronically equipped, are assembled together into rigid module structures by 12 vertical riser wires (3 per edge) which, at the same time, provide structural strength and appropriately connect the circuitry of adjacent wafers. These module assemblies constitute the intrinsic core of the Tinkertoy concept.

The Project Tinkertoy system of manufacture is applicable to hand or machine methods, and is particularly adaptable to automatic machine production.

EXHIBIT 1.

PROJECT
TINKERTOY
CONCEPT





WAFERS

Objectives

Electronic equipment manufactured thus far by Tinkertoy methods has been processed largely on a pilot plant and model shop basis; and not on a conventional industrial production basis.

It became necessary to determine costs of manufacturing for the Tinkertoy system for comparison purposes. Consequently, the objectives of this survey are to:

- 1. Determine the cost of manufacturing a specific item of electronic equipment by Tinkertoy hand and Tinkertoy machine processes, as adapted and projected to conventional production practices.
- 2. Compare these costs with the cost of manufacturing a similar item by conventional methods and practices.

Limitations

The scope of this survey does not include technical evaluation of Project Tinkertoy processes.

As indicated previously, Project Tinkertoy manufacturing observed during this survey was of a pilot plant and/or model shop nature. There was little production experience and data to draw on; particularly in the machine processing operations. Consequently, the cost figures for machine processing were necessarily based largely on estimates for net machine yields, and are subject to revision as operating experience is gained.

The cost figures for hand processing are based to a large extent on time studies of operations. They are, therefore, less subject to revision with the accumulation of production experience, except as necessitated by methods improvements.

Approach

The objectives outlined previously have been accomplished by:

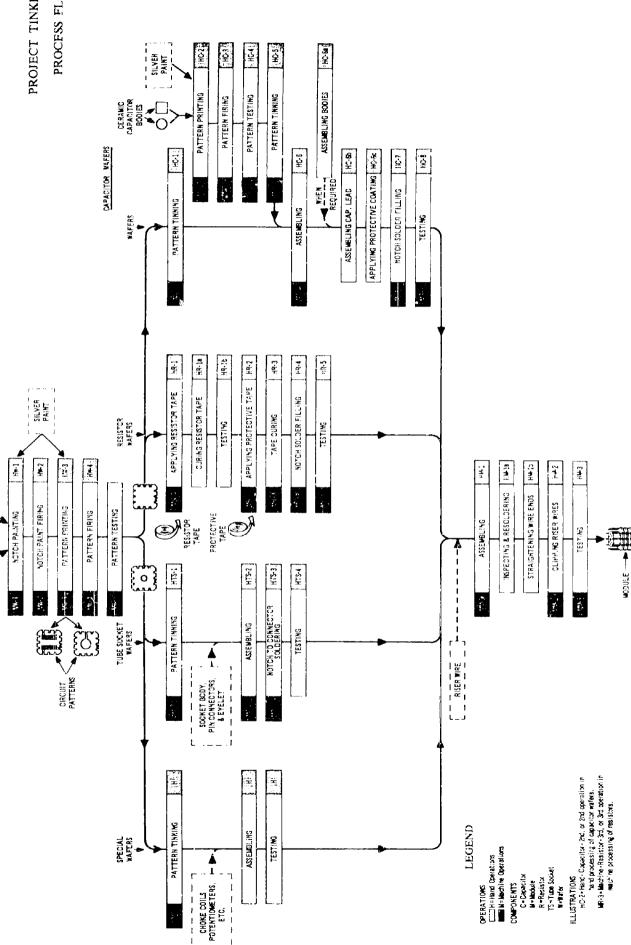
- 1. Analyzing the Project Tinkertoy hand and machine processes to determine process flow, and to delineate the individual process steps. This information was needed to facilitate comparison of each step of the hand and machine processes.
- 2. Selecting an appropriate item of electronic equipment on which to base the cost comparison.
- 3. Establishing a basis for developing cost data for this item, which would have a wide application in both government and industry.
- 4. Evaluating the state of development of the present hand and machine operations on the basis of available historical data, observations, and the estimates of those most familiar with the processes and equipment. This evaluation established sound bases and assumptions for the determination of cost data for a projected commercial operation.

5. Developing costs for:

- a. hand and machine processes, step by step, and establishing breakeven points between the two processes.
- b. individual hand and machine manufactured modules required for the item selected for the cost comparison,
- c. the complete item of equipment selected as a vehicle for cost comparison as manufactured by the Project Tinkertoy hand and machine processes.
- 6. Obtaining costs for the selected item as manufactured by conventional methods, and comparing with the cost of manufacturing the item by Project Tinkertoy methods.

II PROJECT TINKERTOY PROCESS FLOW

EXHIBIT 2. PROJECT TINKERTOY PROCESS FLOW SILVER PAINT CERAMIC WAFERS F ... <u>~</u> NOTCH PAINT FIRMS PATTERN PRINTING NOTCH PAUNTING



III SELECTION OF ITEM FOR COSTING PURPOSES

III—SELECTION OF ITEM FOR COSTING PURPOSES

Criteria:

The following criteria were considered in selecting an item of electronic equipment for use as a vehicle for the cost comparison:

- 1. The item must have been produced by both conventional and Tinkertoy methods.
- 2. It should consist largely of Tinkertoy system components, so as not to mask the economic effects of the application of Tinkertoy to manufacture.
- 3. Manufacturing costs must be obtainable for the conventionally produced version of the item.

Item Selected

The item selected on the basis of the foregoing criteria was an Intermediate-Frequency Amplifier. This unit, illustrated on Exhibit 3 opposite, is similar to interchangeable subassemblies which are incorporated into a variety of complete electronic assemblies. It will be referred to as an IF Amplifier throughout the report.

While the I F Amplifier satisfies the criteria referred to previously, its component modules have been produced by Tinkertoy processes only in a four-wafer design, and only by hand.

These particular four-wafer layouts were not adaptable to machine assembly. Five-wafer modules, adaptable to machine assembly, were therefore laid out for costing purposes. They were carefully checked for electrical correctness.

Though these module layouts have not been built, similar modules have been built and tested. It is considered, therefore, that no significant error will result from using these module layouts for cost comparison purposes.

INTERMEDIATE FREQUENCY (IF) AMPLIFIERS

CONVENTIONAL UNIT

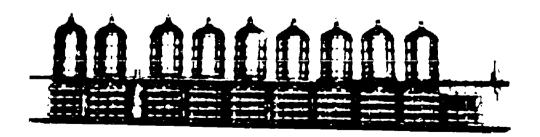


Side



Bottom

PROJECT TINKERTOY UNIT



IV ESTABLISHMENT OF COSTING BASIS

IV—ESTABLISHMENT OF COSTING BASIS

Elements of Cost

The sales price of a product is normally composed of the following major cost elements, as illustrated on Exhibit 4, opposite.

- 1. Profit
- 2. Sales and Administrative Expense
- 3. Manufacturing Costs

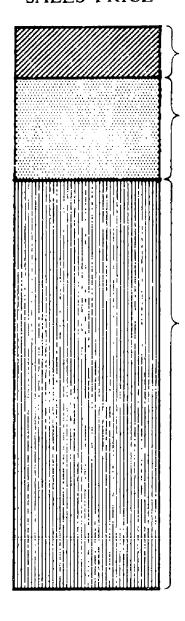
Establishment of Costing Basis

It was decided to use the Manufacturing Cost element of the sales price of a product as the basis for determining and comparing costs for Project Tinkertoy, for the following reasons:

- 1. Manufacturing Cost covers the basic manufacturing and processing expense, and is the element of cost on which the other cost elements are based. It is not particularly affected by extraneous factors such as sales policies, market demand, etc.
- 2. Manufacturing Cost figures can be compared readily with similar cost figures throughout industry, and can be adjusted for more exact comparison, if desired, for any special set of operating conditions.

SALES PRICE OF A PRODUCT

SALES PRICE



- 1. PROFIT
- 2. SALES AND ADMINISTRATIVE EXPENSE

- 3. MANUFACTURING COSTS
 - a. Materials
 - b. Direct Labor
 - c. Manufacturing Overhead
 - (1) Indirect Labor
 - (2) Machine, Equipment, and Tool Expenses
 - (3) Occupancy Expense
 - (4) Miscellaneous Expenses

STANDARD COSTING RATES

In determining the direct labor and manufacturing overhead costs, the representative rates and ratios shown on Exhibit 5 opposite were used.

The percentage of overhead expenses apportioned as fixed costs for use in determining breakeven points between hand and machine processes, are also shown on Exhibit 5.

PROJECT TINKERTOY MANUFACTURING COST STANDARD RATES

OPERATIONS

	OFERA		
ITEM	Rate or Machine	Ratio Hand	Distribution % Fixed Cost
1. WAGE RATES	- 1		
a. Highly skilledb. Skilledc. Semi-skilledd. Unskilled	\$2.40 2.00 1.60 1.20	\$2.40 2.00 1.60 1.20	- - -
2. factory overhead			
a. Indirect Labor (% of direct labor cost)	30%	30%	30%
b. Machine, equipment, tool cost1. Annual Depreciation2. Interest charged on capital	10%	10%	100%
required 3. Annual taxes & insurance	4% 1%	4% 1%	100% 100%
4. Maintenance (% of equipment cost) 5. Utilities	Avg. 20%	5-15%	25%
a. Electricity	.02/kwhr.	.02/kw hr.	<u> </u>
c. Occupancy expense			
 Ratio of Total Space to process space Annual Rental / sq. ft. Annual Heat / sq. ft. Annual Light / sq. ft. 	6/1 \$1.00 .10 .30	5/1 \$.80 .10 .30	- 100% 75% 10%

V DETERMINATION OF MANUFACTURING COSTS

V—DETERMINATION OF MANUFACTURING COSTS

The projected Manufacturing Costs for Project Tinkertoy, consisting of the major cost elements—Material, Direct Labor, and Manufacturing Overhead—outlined in the previous section, were determined according to the following procedures:

Materials Costs

In order to develop manufacturing costs for the Tinkertoy IF Amplifier, it was necessary to establish proper costs for the materials used in its manufacture.

The development of costs for these materials was complicated by:

- 1. The relatively high cost of certain parts such as the ceramic wafers as now produced in small quantities at the pilot plant.
- 2. The necessarily small order quantities for some parts, resulting in comparatively high purchase prices for the items.
- 3. The fact that certain parts, such as base strips, have been handmade for this particular IF Amplifier, making it necessary to determine costs for such parts when manufactured in quantities.

All parts used in the Tinkertoy I F Amplifier are considered to be purchased parts, and the prices for these parts and materials as determined by appropriate appraisal, are shown in Exhibit 6, opposite.

MATERIAL COSTS I F Amplifier.

Base strips	2 x \$.700		\$1.400
Brackets, tube shield	8 x .003		.024
*Cable, input coaxial	1 x 1.280		1.280
Capacitor bodies (regular)	32 x .014		.448
(small)	2 x .007	_	.014
Coil, tuning	1 x .950		.950
Coils, other	3 x .125	_	.375
*Cover assembly	1 x 2.170	_	2.170
Eyelets, tube socket	9 x .002	_	.018
Eyelets, other	$150 \times .005$.750
Plug, output	1 x .75	_	.750
Resistor strips	$37 \times .005$	_	.185
Shield, inner stage	8 x .01	_	.080
Shield, input	1 x .02	_	.020
Shield, tube	9 x .0175		.158
Silver (at \$1.27/troy ounce)			
Capacitor body painting	33 x .001	_	.033
Notch painting	49 x .001	_	.049
Tube socket patterns	9 x .0003	_	.003
Other patterns	66 x .0005	_	.033
Transformer, input	1 x .10	_	.100
*Tube, 6AC5	1 x .48	_	.480
*Tube, 6AK5	8 x 1.21	_	9.680
Tube Socket bodies	9 x .055	_	.495
Tube socket connector pins	63 x .005		.315
Wafer, ceramic	$49 \times .01$	_	.490
Wire, riser	18.75' x .014	_	.263
		<u>-</u>	20.563
		Ç.	20.00

^{*}Same price as for conventional 1 F Amplifier

Direct Labor Costs—Tinkertoy Machine Process

To determine the operator or direct labor requirements for Tinkertoy machine processing, it was first necessary to determine machine and equipment requirements.

All of the Tinkertoy components manufactured to date by the machine process have been produced at a pilot plant established by the National Bureau of Standards, and now being operated by a commercial contractor.

Certain of the machines used have been adapted from standard machines with comparatively little modification. The majority, however, are relatively new designs, though they do contain some standard components.

Observations of the equipment during the survey indicated that the amount of machine delay, particularly from malfunctioning, was considerably higher than might be expected with comparable equipment in a more advanced state of development.

Some improvements have been developed, however, which have not yet been incorporated in the present equipment. Furthermore, experience indicates that development work on any piece of equipment can reduce malfunctioning delays to some extent. It was decided, therefore, that equipment and direct labor requirements based entirely on the current operations of the pilot plant would not provide a representative picture of the Project Tinkertoy machine process. Consequently, net machine production (or yield), and equipment requirements were based on the assumptions in the following section.

Assumptions for Projecting Equipment Yields. The projected machine process yields used in determining direct labor costs are based on:

- 1. Use of new equipment substantially like the present, operated at substantially the present cyclic rates, and incorporating improvements which have been developed during operations to date:
- 2. Machine delay time reflecting:
 - a. The present stage of development of the equipment.
 - b. General industrial practices and conditions with respect to time required for machine set-up, warmup, clean-up, malfunctioning, maintenance, and operator's personal time.
- 3. Reasonable estimates of processed wafers or modules rendered unusable and therefore rejected due to equipment malfunctioning.

The projected yields are generally higher than current experience would indicate, but are considered to be reasonable expectations, based on the foregoing assumptions.

Equipment Requirements. As stated earlier, it was necessary to determine equipment requirements in order to establish operator, or direct labor requirements. The equipment requirements used in determining direct labor costs were based on:

- 1. Equipment yields based on the assumptions tabulated on the previous page.
- 2. The machine capacities necessary to process the required proportions of the various wafer components, such as resistors, capacitors, and tube sockets, comprising the ten modules for the I F Amplifier.

Note: A check of another naval electronic device, produced by both Tinkertoy and conventional methods, indicated the possibility that the IF Amplifier wafer component ratio is representative of such devices. It should be stressed, however, that the production of other items might require larger percentages of tube sockets, resistors, and capacitors, and consequently, additional requirements for certain machines.

- 3. The necessity for a fairly balanced production line, in order to reduce to a minimum the economic loss resulting from unused machine capacity.
- 4. Operation of the facility on a 2-8-5, or two-shift, 8-hour shift, and five-day week b sis.

Production Line Balance and Facility Cost. The machine process yields developed from the foregoing are shown on Exhibit 7, together with the basic cyclic rates, machine delay times, and percentages of rejects on which these data are based.

After developing the equipment yields, the production line was balanced by adding to the present pilot plant operation the machines necessary to reduce to a minimum the total unused machine capacity consistent with a reasonable capital investment requirement. This resulted in a facility equipped to produce 405 five-wafer modules per hour, with an unused machine capacity equal to approximately 17% of the total investment. The number of pieces of equipment required for this facility are shown on Exhibit 7.

The replacement cost of the equipment required for this 405 module-per-hour facility is also shown on Exhibit 7. These costs were established by evaluation of purchase records and estimates of those most familiar with the Jevelopment of the equipment.

Determining Direct Labor Costs. After establishing the equipment requirements, estimates were prepared of the number and skills of the operators needed, based on general industrial practice with similar equipments. These operator requirements are shown on Exhibit 7.

The number of operators, and the wage rates shown on the Standard Rate Sheet, Exhibit 5, were used to determine the machine process direct labor costs used in this survey.

PROJECT TINKERTOY MACHINE PROCESS-EQUIPMENT

l Oper- ation No.	2 Equipment Description	Basic cyclic rate (pos./nr.)	Machine delay (hrs./8 hrs.)	S I i % 'ejects	6 Net machine yield (posi/hil)	7 Factor for 1 F Amplifier	
MW-1	Notch Painter	1,714	2.5	13%	1 060	4.9	
M.W-2	Notch Paint Fiting		· 				
W#-3	Pattern Printe:	750	3.0	{ 5%-	445	4.9 ÷5	
MW-4	Pattern Firing Furnace	2,143	3.0	-	1,339	4.7 ÷ 5	
MW-5	Pattern Tester	3,000	1.5	10%	2,194	4.7	
 MR-1	Resistor Tape Applicator	1,508	2.3	5%	1,069	1.5	
M R-2	Resistor Prot. Tape Applicator	1,500	2.0	5%	1.069	1.5	
MR-3	Resistor Curing Oven	1,200	-	~	1,200	1.5	
MR-4	Resistor Wafer Noton Tinner	579	1.75	10%	408	1.5	
MR-5	Resistor Assembly Tester	632	1.5	; 5% 	j 488	1.5	
 M C-1	Cap. Wafer Pattern Tinner	56C	i i 1.5	5%	432	3.2	
M C-2	Cap. Body Pattern Printer	1,000	2.0	j 1 13%	i 675	3.2	
M C-3	Cap, Body Pattern Oven	1,818	<u> </u> -	-	. 1,818	3.2	
NC4	Cap, Body Pattern Tester	2,143	1.5	5%	1,654	3.2	
M C-5	l Cap, Body Pattern Tinner	5 50	2.0	; 5 %	392	3.2	
MC-6	Cap. Assembler	3 59	2.5	i 5%	234	l 1.7	
MC-7	Cap. Notch Tinner	579	1.75	10%	408	1.7	
MC-8	Cap. Assembly Tester	632	1.5	5%	488	1.7	
MTS-1	Tube Socket Pattern Timning -						
MTS-2	Tube Socket Assembler	240	2.5	5%	156	.9	
HTS-3	Tube Socket Notch Tinner	579	1.75	K.z	408	.9	
MM-I	Module Assembler	125	2.0	10%	84	.9	
MM-2	Module Riser Wire	270	2.0	5%	192	e.	
MM-3	Module Tester	423	1.5	5%	327	.9	

*** Included in MW-3

^{*} HS - Highly Skilled

S — Skilled SS — Semi-skilled

U - Unskilled

^{••} Included in WW-1

AND DIRECT LABOR REQUIREMENTS

	8	9	10	11	12	13	14 Unusêd Ca	15 soacity	16	17
	1 F Modules : per hr. (6 ÷ 7)	Machines required (405 mod/hr.)	Mach replaceme Per Mach,	nt cost	ittems perhir.	required per hr.	(12 -13) 12	Mach. Cost (11 x 14)	Operator Rec Number & *Skills	uirements Composite rate
-						·		·		
	216	2	\$13,500		2,120	1,985	i	\$1,722	2-S, 2-U	\$6.40
	473	1	25,500	26,500	10 IN CAP.	381	TERN OVEN	(SEE MC-3) 3,812	ŀ	- 4.8n
	1,424		9,000	9,000		381			1-5, 1-55 & 1-U	
	467	1	17,300	17,200	1,339 2,194	1,904	71.5%	6,439 2,240	1-H.S.	2.40
	45/		17,000		2,134	1,504	13.2 **	2,240	1*n.s.	2.40
	713	1	12,000	12,000	1,069	508	43.1%	5,175	1-55	1,60
	7 13	i	12,000	12,000	1,069	608	43.1%	5,175	1-55	1.60
	800	I	9,000	9,000	1,200	608	49.3%	4,440	+	-
	271	2	5,750	11,500	815	808	25.5%	2,931	2 -U	2,40
	325	2 :	11,000	22,000	9.76	6 08	37.7%	8,295	2-H\$	4.80
	135	3	7, 50 C	22,800	1,296	1,296	G %	-	3-\$\$	4.80
	211	2	10,000	20,000	1,350	1,296	4 %	800	2-88	3.20
	284	2	9,000	18,000	1,818	1,296	28.7%	5,168	:	-
	517	1	5,500	5,500	1,654	1,296	21.6%	1,190	1-HS	2.40
	123	4	7,600	30,400	1,568	1,296	17.3%	5,273	4-88	6.40
	138	3	27,500	82,500	702	689	1.85%	1,528	6-88	960
	239	2	5,750	11,500	8 16	689	15.6%	1,790	2-U	2.40
	287	2	12,00€	24,000	976	589	29.4%	7,057	2 H S	480
	1	OPE	RATION PE	RFORMED	IN CAP. Y	VAFER PAT	TERN TINNE	R (SEE MC-	1) ————	>
	173	3	32,000	96,000	4 68	365	22.0%	21,277	2-\$, 2-\$\$	7.20
•	452	1	5,750	5,750	408	365	10.5%	606	1-0	1.20
	93	5	31,50Û	157,500	420	365	13.1%	20,625	10-\$\$	15.00
	213	2	14,500	29,000	384	365	4.9%	1,435	2-55	3.20
	363	2	8,000	16,000	654	365	44.2%	7,070	2-55	4.80

\$664,950

\$114,049

The second secon

[†] Included in MR-2

Direct Labor Costs—Tinkertoy Hand Process

Most of the Tinkertoy components manufactured to date by the hand process have been produced in a model shop of the National Bureau of Standards. The major emphasis has been on development, rather than on production, and consequently the methods and worker pace are not equivalent to commercial practice. Direct labor requirements derived solely from current hand operations would not provide a sound basis for cost comparisons with conventional commercial manufacture.

Considering the present state of development of the Tinkertoy hand process, it was decided to time-study the individual manual process steps and to establish production rates per worker, based on general industrial conditions and practices with respect to worker pace, rest periods, personal time allowances, and delay factors.

The production rates per worker for the various hand process steps thus developed and shown on Exhibit 8 are considered to be applicable to the average industrial plant. While methods studies were not within the scope of this survey, specific methods improvements are reflected in several of the rates. It is apparent that production rates, in at least several process steps, may be further increased significantly by methods analysis and improvement.

In order to provide a direct comparison with the projected Tinkertoy machine processing operations, an equivalent Tinkertoy hand processing facility was projected with a capacity of 400 modules per hour. The equipment costs for this facility are also shown on Exhibit 8.

PROJECT TINKERTOY – HAND PROCESS PRODUCTION AND EQUIPMENT DATA

Operation No.	OPERATION DESCRIPTION		Standard Dec.Hrs.Per Operation	Output in Pieces Per Hour	No Operators to Make 400 Mod / Hr	No. Work Stations Req.	Equipment Cost For Work Stations
HW-1	Wafer Notch Painting		.00880	114	17.248	17	\$ 894.30
HW-2	Wafer Notch Paint Firing		.00044	2,273	.8624	(1)	224.40
HW-3	Wafer Pattern Printing	(1 side)	.00091	1,099	.5460	ĺ	9,902.20
HW-3	Wafer Pattern Printing	(2 sides)	.00184	543	2.2080	-2	_
HW-4	Wafer Pattern Firing		.00044	2,273	.8624	(1)	4,730.00
HC-1	Cap. Wafer Pattern Tinning		.00638	157	4.5936	5	937.75
HC-2	Cap. Body Pattern Printing		.00196	510	2.6656	3	7,422.80
HC-2a	Make Cap. Leads		.00055	1,820	.7480	1	100.10
HC-3	Cap. Body Pattern Firing		.00044	2,273	.5808	(1)	3,190.00
HC-4	Cap. Body Pattern Testing		.00176	568	2.3936	3	1,620.30
HC-5	Cap. Body Pattern Tinning		.00396	253	5.3856	5	937.75
HC-6	Cap. Body To Wafer Assembly	(.02+.01)	.01320	76	2.1120	2	1,008.70
HC-6	Cap. Body To Wafer Assembly	(Two.01)	.00715	140	2.2880	2	
HC-6	Cap. Body To Wafer Assembly	(One .02)	.00473	211	1.3240	2	-
HC-6a	Assemble Cap. Leads	(1 side)	.00781	128	3.1244	3	474.93
HC-6a	Assemble Cap. Leads	(2 sides)	.01408	71	6.7584	7	-
HC-6b	Sub-Assemble Cap. Bodies		.00974	103	1.9480	2	378.40
HC-6c	Apply Prot. Coating	(1 sid e)	.00847	118	2.7104	3	334.40
HC-6c	Apply Prot. Coating	(2 sides)	.01694	59	6.7760	7	~
HC-7	Cap. Wafer Notch Solder Filling		.00880	114	6.3360	6	315.49
HC-8	Cap Wafer Assembly Inspections		.00286	350	3.8896	4	2,160.40
HR-I	Res. Tape Application	(1 side)	.00432	232	1.9008	2	135.30
HR-I	Res. Tape Application	(2 sides)	.00620	161	1.2400	1	-
HR-la	Dry Res. Tape		.00044	2,273	.2816	(1)	1,540.00
HR-1b	Inspect		.00550	182	3.3000	4	596.20
HR-2	Prot. Tape Application	(1 side)	.00488	205	1.3664	2	246.40
HR-2	Prot. Tape Application	(2 sides)	.00783	128	2.5056	2	-
HR-3	Dry Prot. Tape		.00044	2,273	.2816	(1)	1,540. 0 0
HR-4	Res. Wafer Notch Solder Filling		.00792	126	4.7520	5	937.75
HR-5	Res. Testing		.00550	182	3.3000	4	477.40
HTS-1	Tube Socket Pattern Tinning		.00589	167	2.1204	2	375.10
HTS-2	T. S. Parts to Wafer Assembly		.01276	79	4.5936	5	1,353.00
HTS-3	T. S. Wafer Notch Solder Filling		.01716	58	6.1776	6	1,395.90
HTS-4	T. S. Inspection		.00524	191	1.8864	2	358.05
HM-1	Module Assembly		.04235	24	16.9400		17,576.90
HM-la	Inspect & Resolder		.01749	57	6.9960	7	373.42
HM-1b	Straighten Wire Ends		.00880	114	3.5200	4	200.20
HM-2	Riser Wire Clipping		.01716	58	6.8640	7	508.20
HM-3	Module Testing		.00275	364	1.1000		18,123.00
	Special Items		.05500	18	2.2000	4	201.65
	Final Assembly		.38500	2.6	15.4000	16	1,249.60
	TOTAL				182.0868	167	\$81,819.99

Manufacturing Overhead Costs

The manufacturing overhead costs for the various cost comparisons developed in this survey were determined in the following manner:

Indirect Labor includes plant supervision, clerical, shipping and receiving, quality control, material handling, janitor and watchman service, etc.

The indirect labor expense was developed by estimating the wages and salaries of the personnel required to service commercial facilities similar to those projected for Tinkertoy hand and Tinkertoy machine processing. This expense, compared to the estimated total expense for direct labor, provided the 30% ratio shown on the Standard Rate Sheet, and used in distributing indirect labor costs to the various process steps for both hand and machine manufacture.

Machine, Equipment, & Tool Expense covers depreciation, interest charges for capital requirements, taxes and insurance, power consumption, and maintenance labor, materials, and overhead for all machines, equipment, and tools used.

This expense was developed by using standard rates, as shown on the Standard Rate Sheet, for depreciation, interest, and taxes and insurance and applying them to the estimated replacement costs of equipment required. To this was added the estimated maintenance and power expenses for the equipment, to obtain the total. The work sheet used to develop this expense is shown as Exhibit 9.

Annı	ual Equipment Costs Based on Shifts and	Hrs. Operations		
1,	Depreciation	Total	Fixed	Variable
	Replacement Cost of Item	xx	xx	××
	Annual Depreciation Rate 10%	xx	xx	xx
	Annual Depreciation		100 90	xx
2.	Interest charge for Capital required		1400	
	Replacement Cost x Rate % 4%	<u> </u>	100%	xx
3.	Taxes & Insurance	××	хx	xx
	Replacement Cost 170	1	100%	xx
4.	Maintenance		25%	75%
5.	Utilities KW Hrs. x Rate -02	-	хx	100%
6.	Miscellaneous			
				
				
	TOTAL COSTS			
		xx	xx	xx
Note	:			
 ,				
				
				

Occupancy Expense was determined by estimating the space requirements of the facilities needed for the various operations, and multiplying the space by the average rates for rent, heat, and lights, shown on the Standard Rate Sheet. It will be noted that a lower rental rate was used for hand processing space than for machine processing space, based on the general practice of using more expensive space for automatic equipment installations.

Miscellaneous Expenses are numerous expenses incurred in connection with manufacturing facilities and operations, such as supplies, water and gas, employee benefits, loss and wastage, etc., for which it is difficult to establish general averages. However, it appeared reasonable to use a figure of 10% of the "Indirect Labor," "Machine, Equipment & Tool Expense," and "Occupancy Expense," to cover these miscellaneous expenses, and this 10% figure is used throughout this manufacturing cost determination.

Assembling Manufacturing Cost Data

The Manufacturing Cost Data for each step of the Project Tinkertoy machine and hand processes was developed as outlined in the preceding sections, and the data was assembled on work sheets illustrated on Exhibit 10, opposite.

The distribution between fixed and variable expenses was made according to the percentages shown on Exhibits 5 and 9.

PROJECT TINKERTOY -- Manufacturing Cost Data

Processes _		Mach. Hand	No	·	
Equipment _			No		
Based on	shifts,	hrs., hourly prod.			•
			<u>A</u>	nnual Co	est
	Item		Total	Fixed	Variable
l. Material				хх	
2. Direct La	bor = Hrs	x Rate =	===	хх	
3. Manufacti a. Indir		ad 30% of Direct=	*		
b. Mach	ine, Equipme	ent & Tool			
c. Occuj Pro	Rent Light	x Ratio z	_ xx	xx	xx
d Mina		tal - a, b, and c.	~~~~		
d, Misc		- a, b, c, and d.			
		GRAND TOTALS			
Notes:				·	حديث بديد
					
		···			

VI PROJECT TINKERTOY PROCESS STEP COMPARATIVE COSTS

VI-PROCESS STEP COMPARATIVE COSTS

Having developed complete manufacturing cost data, based on projected manufacturing facilities with capacities of 405 modules per hour for the Tinkertoy machine process and 400 modules an hour for the equivalent hand process, a comparison of the manufacturing costs for each step in the machine process was prepared.

These comparative process step costs per item processed are tabulated on Exhibit 11 opposite. The lower of the two costs is underlined to facilitate comparison at each step.

For each machine process step, a chart was also prepared depicting the variation between the manufacturing cost characteristics for the machine step and the comparable hand process step(s). These cost-volume charts involved utilization of the fixed cost overhead expense ratios referred to in Exhibit 5.

Wherever the cost characteristics for a machine process step and its equivalent hand process step(s) converged, and therefore, would intersect, a break-even volume was thereby determinable at which the manufacturing costs for both processes are identical. These break-even volumes were then determined by algebraic calculation, checked for correlation with the appropriate charts, and tabulated in Exhibit 11.

PROJECT TINKERTOY - PROCESS STEP COMPARATIVE COSTS
(Direct Labor and Manufacturing Overhead)

_		HA	AND	MACH	IINE	l
Oper. No.	OPERATION DESCRIPTION	Unit Cost	Annual Volume**	Unit Cœt	Annual Volume	Break- even Volume ^{ee}
Basic Wa	fer Preparation					}
W-1, 2	Wafer Notch Painting & Firing	.0201	7,840	.00663	7,938	None
W-3, 4, 5	Wafer Pattern Printing, Firing, Testing	.00498	7,200	.00342	7,614	None
Resistor	Wafer Preparation					
R-1	Resistor Tape Application	.0235	2,400	.00477	2,430	None
R-2	Protective Tape Application	.0141	2,400	.00477	2,430	67
R-3	Tape Curing	.00152	2,400	.00141	2,430	1,930
R-4	Wafer Notch Solder Filling	.0174	2,400	.00797	2,430	30
R-5	Inspection	.0121	2,400	.0124	2,430	2,915
Capacito	Wafer Preparation					
C-1	Wafer Pattern Tinning	.0140	2,880	.00584	3,390	140***
C-2, 3	Body Pattern Printing & Firing	.00717	5,440	.00612	5,184	2,179
C-4	Body Pattern Testing	.00392	5,440	.0028	5,184	219
C-5	Body Pattern Tinning	.00866	5,440	.00917	5,184	8,969
C-6	Body to Wafer Assembly	.082†	2,880	.0327	2,754	101†
C-7	Wafer Assem. Notch Solder Filling	.0192	2,880	.00674	2,754	None
C-8	Inspection	.0120	2,880	.0121	2,754	2,939
Tube Soc	ket Wafer Preparation					
TS-1	Wafer Pattern Tinning	.0129	1,440	.00584	1,794	See C-1
TS-2	Parts to Wafer Assembly	.028	1,440	.0546	1,458	None
TS-3	Notch Solder Filling	.0375	1,440	.0063	1,458	None
Module Assembly						
M-1	Assembly	.0958	1,600	.1096	1,458	3,510
M-2	Riser Wire Clipping	.0375	1,600	.0212	1,458	204
M-3	Testing	.00928	1,600	.01325	1,458	None
™In thouse	by "H" for hand processes, and "M" for runds.	nachine proc	esses,			

For C-1 and TS-1 combined.

^{*}For H-6, 6a, 6b, 5c combined.

VII I F AMPLIFIER MODULE COMPARATIVE COSTS

VII — I F AMPLIFIER MODULE COMPARATIVE COSTS

The processing costs for the ten Tinkertoy I F Amplifier modules were determined according to the procedures previously outlined, and are shown in the following tabulation.

	Dissot	Labor	Manufe Over	-	το:	TALS
MODULE	Hand	Machine	Hand	Machine	Hand	Machine
M-1	.46514	.1483	.16823	.1392	.63337	.2875
M-2	.50031	.2209	.19535	.27464	.69566	.49544
M-3	.51031	.2209	.19815	.27464	.70846	.49554
M-4	.62458	.23886	.22821	.29286	.85279	.53172
M-5	.55956	.23977	.22746	.29850	.78702	.53827
M-6	.51961	.21342	.18702	.26786	.70663	.48128
M -7	.52111	.2209	.19435	.27464	.71546	.49554
M-8	.63576	.28313	.23481	.30701	.87057	.59014
M-9	.63468	.25118	.24730	.27139	.88198	.52257
M-10	.40372	.18195	.16065	.23558	.56437	.41750
	5.375	2.219	2.042	2.636	7.416	4.856

VIII I F AMPLIFIER COMPARATIVE. COSTS

VIII—I F AMPLIFIER COMPARATIVE COSTS

The manufacturing costs of the complete I F Amplifier were determined for both Tinkertoy hand and machine operations, based on the processing and materials costs previously shown, and on the final assembly costs detailed in an appendix to this report.

Manufacturing costs for the conventional I F Amplifier were obtained from a Navy contractor who had produced a considerable quantity of the item. These costs, together with similar costs for Project Tinkertoy hand and machine processing, are tabulated below.

метнор	MATERIALS	DIRECT LABOR	MFG. O. H.	TOTALS
Conventional	\$35.85	\$5.60	\$5.44	\$46.89
Tinkertoy Hand	20.56	5.99	2.27	28.82
Tinkertoy Machir	ne 20.56	2.83	2.86	26.25

IX CONCLUSIONS

IX - CONCLUSIONS

The significant conclusions of this survey are as follows:

- Substantial reductions in electronic manufacturing costs appear to be possible through the use of either Project Tinkertoy machine or hand processes, as compared with conventional manufacturing methods. Based on the survey projections, the manufacturing cost reductions amount to 44% for the Tinkertoy machine process, and 38.5% for the Tinkertoy hand process.
- Manufacturing costs are lower for the Project Tinkertoy machine processing operations than for the hand processes in 13 of the 20 process steps, or groups of steps, delineated for this survey and indicate a 8.9% lower manufacturing cost for a complete I F Amplifier manufactured by Tinkertoy machine processes as compared to Tinkertoy hand processes.
- The substitution of lower-cost hand process steps, where appropriate, would result in a lower total manufacturing cost for the I F Amplifier than the present projected machine process total cost.
- The \$665,000 investment required for the projected 405 module per hour machine process facility is approximately 8 times the \$82,000 investment for the 400 module per hour hand process facility, but the difference in investment would be repaid from manufacturing cost savings within less than one year and five months of operations at full capacity.

- The Tinkertoy machine process uses fewer labor hours per unit produced than does the hand process, but requires a larger proportion of higher skilled personnel.
- Little, if any, manufacturing cost reduction would result solely from an increase in size of the projected Tinkertoy hand or machine process facilities. (Some reduction in material costs might be expected from larger purchase order quantities.)
- Significant reductions may be achieved in the present Tinkertoy hand process costs through methods improvements in several of the process steps.
- Significant reductions in the present Tinkertoy machine process costs would result from:

Increases in equipment cyclic rates.

Reductions in machine delay time.

Reductions in percentages of rejects.

Reductions in equipment costs.

Reductions in numbers and skills of operators.

Reductions in equipment maintenance costs.



PROJECT TINKERTOY

Manufacturing Cost Determination

Appendixes

- A. Ceramic Wafer Manufacturing & Cost Data
- B. Project Tinkertoy Processing Cost Data Sheets & Cost Volume Charts
- C. IF Amplifier Module Cost Data
- D. IF Amplifier Assembly & Test Cost Data

APPENDIX A

Ceramic Wafer Manufacturing & Cost Data

Schedules	Description
A = 1	Ceramic Wafer Cost Determination
A-2	Wafer Manufacturing Process Flow
A-3	Wafer Manufacturing Equipment & Cost Data
A-4	Hand Process Wafer Manufacturing Cost Data
A-5	Hand Process Wafer Equipment Cost Data
A-6	Machine Process Wafer Manufacturing Cost Data
A-7	Machine Process Wafer Equipment Cost Data

CERAMIC WAFER COST DETERMINATION

Objective determination of the manufacturing cost for the ceramic module wafer was complicated by the fact that the present facility is largely developmental in nature, and that some of the equipment is used for both module wafers and experimental capacitor wafers. In addition, the facility had been transferred from operation by the National Bureau of Standards to operation by a private contractor but two weeks before the start of the cost determination study.

Wherever possible, production capacities were determined by actual count or time study, as in the cases of wafer pressing, firing and gaging. In the remaining cases, the necessary data was obtained through the medium of statistical sampling and the analysis of available production statistics.

The wafer manufacturing process sequence is shown on Schedule A-2. It was found that, with the present module firing kiln and drying oven fully loaded on a 24-hour basis, the remainder of the processing equipment was very much under-utilized. It was considered appropriate, therefore, in order to achieve better utilization of this equipment for costing purposes and to approximate therefor a more normal manufacturing facility, to quadruple the kiln and oven capacities. This resulted in a costing basis of 52,000 wafers per 24-hour day, based on a maximum practical capacity of 13,000 wafers per 24-hour day for each furnace at 85% of optimum kiln capacity.

With the quadrupled kiln capacity, the kilns would continue to be the limiting factor in determining production capacity. Since the kilns are essentially intended to run on a continuous (24-hour a day) basis, except for necessary time out for repairs, this provided the basis for determination of yearly production capacity.

Appraisal of maintenance requirements for the wafer processing equipment, through consultation with pertinent operating personnel, revealed the need for shutting down each kiln one day per week, on the average, for maintenance and repairs and two weeks per year for rebuilding of refractory linings. Hence, with four kilns producing 52,000 wafers per day, the maximum practical capacity of the costing basis production facility became 15,600,000 wafers per 300-day year.

Ceramic Wafer Cost Determination (cont'd)

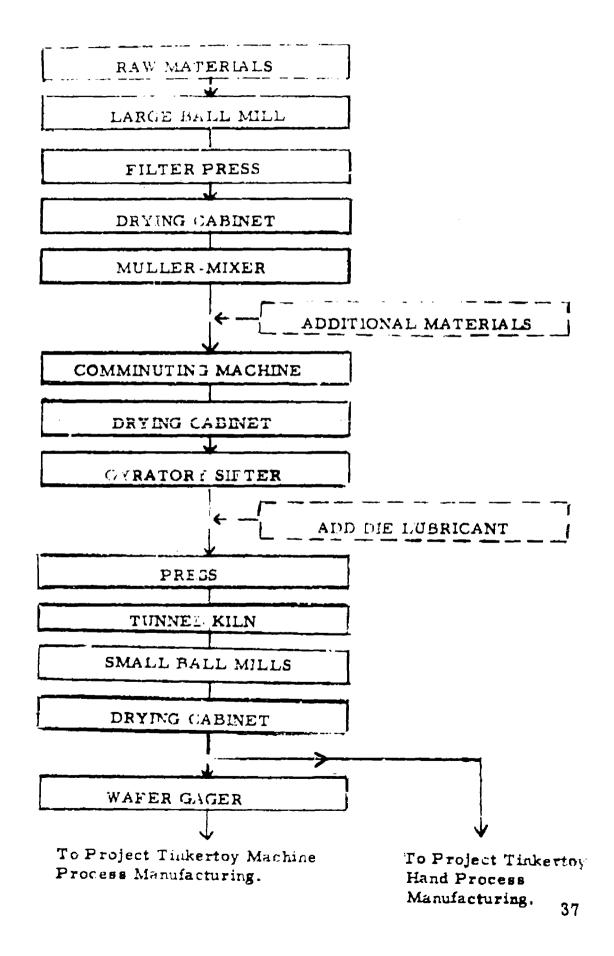
Analysis of some eight production batches completed during the period of the study indicated that an average yield of approximately 28,500 wafers per batch could be conservatively expected in normal production. This provided the basis for costing in the materials at the appraised cost of \$16.50 per batch.

The analysis also indicated that, in the case of wafers intended for use in machine wafer and module fabrication, approximately 20% of kiln production would be rejected at the wafer gager as not being acceptable therefor. These rejects could, however, be credited as being usable for hand module fabrication wherein a lower degree of dimensional precision in the wafer is acceptable.

These, then, were the bases upon which the module wafer cost determinations were predicated. Detailed costing data is tabulated on Schedule A-3 of this appendix. Schedules A-4 and A-5 contain the cost determination of the wafer for use in hand fabrication. Determination of the cost of the wafer for machine fabrication purposes is presented on Schedules A-6 and A-7.

PROSECT TIMERTOY

Water Manufacturing Process Flow



250,14

250,11

PRODUCT S DATESTON

Appendix A. Schedule 1-3

CERAMID POINTE HAFER MANIFACTURING BOUTRACHT AND COST DATA SHEAT

(Based on plant producing 24 hours per day, 300 days per year)

#ith production rates of: (a) Wafers acceptable for Mard Fabrication - 52,000 per day = 15,600,000 per year

(With 20% rejected at Gager) (b) Wafers acceptable for Machine Fabrication-41,600 per days 12,480,000 per year

Solumn H Direct Later	rar pome.				Four semi-skilled men per shift				(Two semi-skilled men on let and 2rd	(surres, one on ordering	(One skilled leading man	(per ahift				
Column C Direct Labor	Day &				153.50				7	77. Ten	80 tup 48.00		265,60	28.80	294.40	
1000	Supplies	100	9	120	9	3	85	3 8	8,480	38,816	700) (09	28,396	2,000	39,3%	
Column F	Fabor	116	şe	3	92	92	116	9/2	880die s8,480	5,376	*	9,6	7,058	1,444	8,502	2.550
Column B Space Cremyfed	Sarreet	87	×	112	2.5	30	87	ជ	ß	1,040	ત	629	2,062	*	2,098	plus 30% 0.H.
Column D INH Power	24 hr day	3	(m)	8	57	ጸ	•	αt	72	3,812	90		4,553	6	235,4	n Td
	dar	23	91	72 × 7	20	æ	90	ထ	run 23	72 x 7	80	As regd.		23		
Column B Estimated Replacement	Cost B	1,627	88	9,440	3,830	1,837	1,613	760	096,9	31,600	5843	1,569	\$58,019	3,500	¢61,519	
Column A	lyre of kautomat	Large Ball Mill	Filts: Press	Drying Cabinets	Miller Mixer	Comminuting Machine	Gyrator Sifter	Granular Blender	Dual Fressure Presses	Tunnel Kilns	Smell ball Mill	Misc. Auxiliary Equipment	Hand Fabrication Totales	Wafer Gager	Mobine Fabrication Totalsi	
Pos.of Ront.	Berge		٦	4	rt	7	7	-	~ 1	4	ч		Hand Fabr	- 4	Lohing F	

HAND PROCESS WAFER

PROJECT TINKERTOY Manufacturing Cost	Data	
Processes Module Wafer Manufacture	Hand	No
Equipment See Schedule A-3, Column A		:
Based on 3 shifts, 7200 hrs., 24 hourly prod.	52,000 and	300 day /annua' prod. 15,600,000
<u>Item</u>		Total Annual Costs
1. Material - \$16.50 per batch x 15,600,000 28,500 per batch		\$ <u>9,031.61</u>
2. Direct Labor - See Schedule A-3, Col. G		79,680.00
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. \$79,680		23,904.00
b. Mach., Equip. & Tool (See Schedule A-5)		73,592.25
c. Occupancy " (Per Schedule A-3, Col. E) Proc. Space 2062 x Ratio 6 = 12,372 sq. 1 @ \$1.40 sq. 1		17,320.80
Subtotal - a,b,	and c	\$114,817.05
d. Miscellaneous = 10% x Subtotal 114,817.0	<u>5</u> =	11,481.70
Total - a, b, c,	and d	125, 298. 75
GRAND TOTALS - Items 1, 2	& 3	\$215,010.36
Notes: Manufacturing cost per Module Wafer f	or Hand Fa	brication = \$215,010.36 15,600,000 = 1.378 cents
AddSales and Administration Costs (15%	%) and Prof	it (10%)

Totalling 25% of Selling Price

Purchase Price

- 0.460

■ 1.338 cents

HAND PROCESS WAFER

PROJECT TINKERTOY -- Machine, Equipment & Tool Cost Data

Annual Equipment Costs Based on 3 shifts and 7200 hrs.

		Total
ι.	Depreciation	
	Replacement Cost of Item \$58,019.00 (Per Schedule A-3, Col. B)	
	Annual Depreciation Rate 10%	
	Annual Depreciation \$5,801.90	\$ 5,801.90
2.	Interest Charge for Capital Required	
	Replacement Cost \$58,019.00 x Rate 4% = (Per Schedule A-3, Col. B)	2,320.76
3.	Taxes & Insurance 1%	580. 19
4.	Maintenance (Per Schedule A-3, Col. F)	37,571.40
5.	Utilities - KW Hrs. 4553 x 300 x Rate .02 (Per Schedule A-3, Col. D)	27,318.00
	Total Costs	\$ <u>73,592.25</u>

MACHINE PROCESS WAFER

PROJECT TINKERTOY -- Total Manufacturing Cost Data

Process Module Wafer Manufacture Mach.

Equipment See Schedule A-3, Column A

52,000 x 8 = 300 day 15,000,000 x .8 =

Based on 3 shifts, 7200 hrs., 24 hourly prod./41,600 and/annual prod./12,480,000

Dased on 5 states, and man, bi nourly produ, 11,000 an	ia, anniar proc.,
<u>Item</u> To	otal Annual Costs
1. Material - $\frac{$16.50 \text{ per batch} \times 15,600,000}{28,500 \text{ per batch}}$	\$ 9,031.61
2. Direct Labor - See Schedule A-3, Col. G	88,320.00
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. \$88,320 =	26,496.00
b. Mach., Equip. & Tool - See Schedule A-7	78,048.45
c. Occupancy = Proc. Space 2098 x Ratio 6 = 12,588 sq. ft. @ 1.40 sq. ft. = (Per Schedule A-3, Col. E)	17,623.20
Subtotal - a, b, and c	122, 167. 65
d. Miscellaneous = Subtotal x 10%	12,216.76
<u>Total</u> - 1,2,3	231,736.02
Less credit for 3, 120,000 rejected wafers salable for hand module fabrication @ 1.838¢ per wafer.	57,345.60
GRAND TOTAL	\$174,390.42

Notes: Price per Module Wafer for Machine Fabrication =

 $\frac{$174,390,42}{12,480,000} = 1.397 \text{ cents}$

Add Sales and Administration Costs (15%) and Profit (10%) Totalling 25% of Selling Price = 0.466

1.863 cents

MACHINE PROCESS WAFER

PROJECT TINKERTOY -- Machine, Equipment & Tool Cost Data

Annual Equipment Costs Based on 3 shifts and 7200 hrs.

		Total
1	Depreciation	
-	Replacement Cost of Item \$61,519 (Per Schedule A-3, Col. B)	
	Annual Depreciation Rate 10%	
	Annual Depreciation \$6,151.90	\$6,151.90
2.	Interest Charge for Capital Required	
	Replacement Cost \$61,519 x Rate 4% = (Per Schedule A-3, Col. B)	2,460.76
3.	Taxes and Insurance 1%	615. 19
4.	Maintenance (Per Schedule A-3, Col. F)	41,448.60
5.	Utilities - KW Hrs. 4562 x 300 x Rate . 02 =	
	Total Utilities	27, 372. 00
•	Total Costs	\$78,048.45

APPENDIX B

Project Tinkertoy Processing Cost Data

Schedules	Description
Basic Wa	fer Preparation
B-1	(W1 & 2) Wafer Notch Painting & Firing
B-2	(W3, 4, & 5) Wafer Pattern Printing, Firing & Testing
Resistor	Wafer Preparation
B-3	(R-1) Resistor Tape Application
B-4	(R-2) Resistor Protective Tape Application
B-5	(R-3) Resistor & Protective Tape Curing
B-6	(R-4) Resistor Wafer Notch Solder Filling
B-7	(R-5) Resistor Inspection
Capacitor	Wafer Preparation
B-8	(C-1) Capacitor Wafer Pattern Tinning
B-9	(C-2 & 3) Capacitor Body Pattern Printing & Firing
B-10	(C-4) Capacitor Body Pattern Testing
B-11	(C-5) Capacitor Body Pattern Tinning
B-12	(C-6) Capacitor Body to Wafer Assembly
B-13	(C-7) Capacitor Wafer Notch Solder Filling
B-14	(C-8) Capacitor Inspection
Tube Sock	cet Wafer Preparation
B-15	(TS-1) TS Wafer Pattern Tinning
B-16	(TS-2) TS Parts to Wafer Assembly
B-17	(TS-3) TS Wafer Notch Solder Filling
B-18	(TS-4) TS Inspection
Module A	ssembly
B-19	(M-1) Module Assembly
B-20	(M-2) Module Riser Wire Clipping
B-21	(M-3) Module Testing

Total Cost

B-22 Total Projected Manufacturing Costs for Project Tinkertoy
Hand and Machine Processes

Processes Wafer Notch Painting & Firing Mach. No. MW-1 & 2

Equipment See MW-1 & 2 Data Sheets

Based on 2 shifts, 3,744 hrs., hourly prod. 2,120 and annual prod. 7,938,000

	Annual Cost						
	Total	Fixed	Variable				
MW-1 =	\$47,394	\$ 9,507	\$37,887				
MW-2 •	5, 224	2,724	2,500				
Totals	\$52,618	\$ 12,231	\$40,387				

Notes:

Cost per piece for MW-1 & 2 =

\$52,618 - .00663 7,938,000

Process Wafer Notch Painting Mach. No. MW-1

Equipment 2-Notch Painters (A)

Based on 2 shifts, 3744 hrs., hourly prod. 2120 and annual prod. 7,938,000 wafers

	Annual Cost		
	Total	Fixed	Variable
1. Material	¬•■	xx	
2. Direct Labor = Hrs. 4,000 x Rate 6.40 (B) =	\$25,600	xx	\$25,600
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 25,600 =	7,680	\$2,304	5,376
b. Mach., Equip. & Tool	11,344	5,716	5,628
c. Occupancy = Proc. Space 94 x Ratio 6 = 564 sq. ft. Rent 1.00 x 564 = Light .30 x 564 = Heat .10 x 564 =	564 169 56	564 17 48	152 14
Subtotal - a, b, and c	\$19,813	\$8,643	\$11, 170
d. Miscellaneous = 10% x Subtotal 19,813 = Total - a,b,c, and d	1,981	864	1,117
GRAND TOTALS	\$47,394	\$9,507	\$37,887

Notes:

(A) 2-Notch Painters @ \$13,500 = \$27,000

Cost per piece for $MW-1 = \frac{$47,394}{7,938,000} = .0059$

Process Wafer Notch Paint Firing Mach. No. MW-2

Equipment 1-Furnace (A)

Based on 2 shifts, 3744 hrs., hourly prod. 2,120 and annual prod. 7,938,000 wafers

		Annual Costs	
Item	Total	Fixed	Variable
1. Material	•	xić	
2. Direct Labor = Hrs. (B) x Rate		xx	
 Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 			
b. Mach., Equip. & Tool	\$3,674	\$1,628	\$2,046
c. Occupancy = Proc. Space 128 x Ratio 6 = 768 sq.ft. Rent 768 x 1.00 = Light 768 x .30 = Heat 768 x .10 =	768 230 77	768 23 57	207 20
Subtotal - a,b, and c	\$4,749	\$2,476	\$2,273
d. Miscellaneous = 10% x Subtotal = 4,749	475	248	227
Total - a,b,c, and d	5,224	2,724	2,500
GRAND TOTALS	\$ <u>5,224</u>	\$2,724	\$2,500

Notes:

- (A) 1-Furnace @ \$9,000
- (B) Direct Labor Included in MW-1

MC-3 Operation includes balance of cost

Cost per piece = \$5,224 = .00066 7,938,000

PROJECT	TINKERTOY		Manufacturing Cost Data	
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Process Wafer Notch Painting & Firing Hand No. HW-1 & 2

Based on 2 shifts, 4000 hrs., hourly prod. 1960 and annual prod. 7,840,000

Annual Cost

	Total	Fixed	Variable
HW-1 =	\$150,377.00	\$12,388.00	\$137,989.00
HW-2 =	7, 390, 88	513, 40	6,877.48
Totals -	\$ 157, 767. 88	\$12,901.40	\$144,866.48

Notes: Cost per piece for HW-1 and $2 = \frac{$157,767.88}{7,840,000} = .0201$

Process Wafer Notch Painting	Hand	No. HW-	l
Equipment (A)			
Based on 2 shifts, 4000 hrs., hourly prod. 19	60 and annual	prod, 7,840,	000
	Annual Costs		
<u>Item</u>	Total	Fixed	Variable
l. Material		xx	
2. Direct Labor = Hrs. 68,992 x Rate 1.6 (B) =	\$110,387.00	xx	\$110,387.00
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 110,387 =	33,116.00	\$ 9,935.00	23,181.00
b. Mach., Equip. & Tool	178.80	145.27	33, 53
c. Occupancy = Proc. Space 510 (C) x Ratio 5 = 2550 sq. Rent	2,040.00 765.00 255.00	2,040.00 76.50 191.25	688.50 63.75
Subtotal - a,b, and c	\$ 36,354.80		•
d. Miscellaneous = $10\% \times \text{Subtotal} = \frac{36,354.80}{} =$	3,635,48		3,635.48
Total - a, b, c, and d	39, 990, 28		
GRAND TOTALS	\$150,377.00	\$12,388.00	\$137,989.00

Notes:

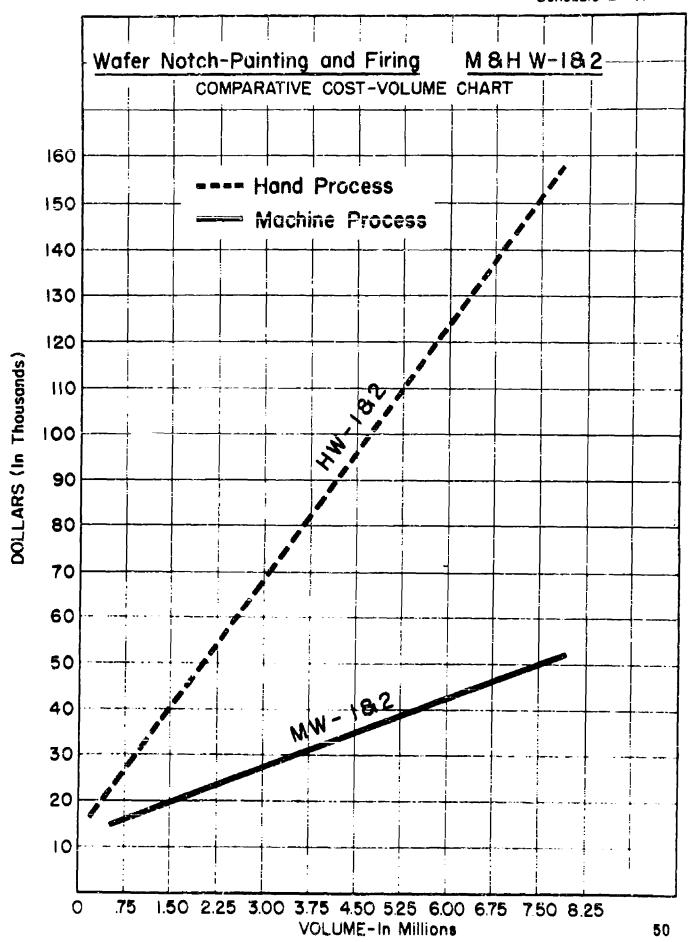
- (A) Notch Painting Tool, Bench & Stool. Cost for 17 station = \$894.30.
- (B) Based on 17.24 men per hour per 40 modules per hour for 4,000 hours annually.
- (C) Based on process space for 17 stations.

Cost per piece = $\frac{$150,377}{7,840,000}$ = .0192

Process Wafer Notch Paint Firing Hand No. HW-2 Equipment Benches, Stools and Infra-red Lamps Based on 2 shifts, 4000 hrs., hourly prod. 1960 and annual prod. 7,840,000 Annual Cost Item Total Fixed Variable 1. Material Xx 2. Direct Labor = Hrs. 3,450 x Rate 1.6 = \$5,520.00 \$5,520.00 $\mathbf{x}\mathbf{x}$ 3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 5,520 = 1,656,00 \$477.00 1,179.00 b. Mach., Equip. & Tool 44.80 36.40 8.40 c. Occupancy = Process Space (A) x Ratio Subtotal - a, b, and c \$1,700.80 d. Miscellaneous = 10% x Subtotal 1,700.80 = 170.08 170.08 Total - a, b, c and d 1,870,88 GRAND TOTAL \$7,390.88 \$513.40 \$6,877.48

Notes: (A) Part of operation HW-1 space.used.

Cost per piece = \$7,390.88 = .0009427 7,840,000



Processes Wafer Pattern Printing, Firing, Test. Mach. No. MW-3, 4 & 5

Equipment See MW-3, 4 & 5 Data Sheet

Based on 2 shifts, 4,000 hrs., hourly prod. 2,225 and annual prod. 7,614,000

	Annual Cost			
	Total	Fixed	Variable	
MW-3	\$38,809	\$ 9,014	\$29,795	
MW-4	4,758	2,826	1,932	
MW-5	20,531	5,137	15,394	
Total	\$64,098	\$16,977	\$47,121	

Notes:

Cost per piece for MW-3, 4 and 5 =

\$64,098 = .00842 7,614,000

Processes Wafer Pattern Printing	Mach,	No. MY	V - 3
Equipment 1 Wafer Pattern Printer (A)	~		
Based on 2 shifts, 3,422 hrs., hrly. prod. 2,	225 and annua	il prod. 7,6	614,000
		Annual Co	st
	Total	Fixed	Variable
1. Material		ж	
2. Direct Labor =			
Hrs. 4,000 x Rate 4.80 (B) =	\$19,200	хх	\$19,200
3. Manufacturing Overhead			
a. Ind. Lab. = 30% of Dir. 19,200 =	5,760	\$1,728	4,032
b. Mach., Equip. & Tool	10, 983	5,611	5,372
c. Occupancy =			
Proc. Space $129 \times \text{Ratio } 6 = 774 \text{ sq. ft.}$			
Rent 774 x 1,00 =	774	774	• • •
Light 774 x .30	232	23	209
Heat $774 \times .10 =$	77	58	19
Subtotal - a, b, and c	\$17,826	\$8,194	\$ 9,632
d. Miscellaneous =			
$10\% \times Subtotal 17,826 =$	1,783	820	963
Total - a, b, c, and d	19,609	9,014	10,595
GRAND TOTALS	\$38,809	\$9,014	\$29,795

Notes:

- (A) 1 Pattern printer @ \$26,500
- (B) 1 Skilled \$2.00 1 Scmi-skilled - 1.60 1 Unskilled - 1.20 \$4.80

Cost per piece = \$38,809 = .0051 7,614,000

PROJECT TINKERTOY -- Manufacturing Cost Data No. MW-4 Processes Wafer Pattern Firing Mach. Equipment 1 Furnace (A) Based on 2 shifts, 3422 hrs., hourly prod. 2,225 and arnual prod. 7,614,000 Annual Gost Item Total Fixed Variable l. Material ХX 2. Direct Labor = Hrs. (B) x Rate ХX 3. Manufacturing Overhead a. Ind. Lab. b. Mach., Equip. & Tool \$3,132 \$1,628 \$1,504 c. Occupancy = Proc. Space 142 x Ratio 6 = 852 sq. ft. Rent 852×1.00 852 852 $852 \times .30$ Light 256 26 230 852 x .10 Heat 85 63 2.2 \$4,325 \$2,569 Subtotal - a,b, and c \$1,756 d. Miscellaneous : $10\% \times Subtotal 4,325 =$ 433 257 176 Total - a, b, c, and d \$4,758 \$2,826 \$1,932 GRAND TOTALS \$4,758 \$2,826 **\$**1,932

Notes:

- (A) 1 Furnace @ \$9,000
- (B) Direct Labor Included in MW-3

Cost per piece = $\frac{$4,758}{7,614,000}$ = .00062

Processes Wafer Pattern	Testing	Mach,	No1	MW-5
Equipment Pattern Test	ter (A)			
Based on 2 shifts, 3,470 h	hrs., hourly prod. 2	, 194 and annua	al prod.	7,614,000
			Annual (Cost
		Total	Fixed	Variable
l. Material			ХX	
2. Direct Labor •		_		
Hrs. 4,000 x Rate 2	. 40 (B) =	\$ 9,600	хx	\$ 9,600
3. Manufacturing Overheada. Ind. Lab. = 30% of I		2,880	\$ 864	2,016
b. Mach. Equipment &	Trol	6,796	3,599	3,197
c. Occupancy = Proc. Space 31 x Ra	itio 6 = 186 sq.ft.			
Rent 186 x 1.00	0	186	186	^- - -
Light $186 \times .30$		56	6	50
Heat 186 x , 10	0	19	15	4
S	Subtotal - a, b, and c	9,937	4,670	5,267
d. Miscellaneous =				
10% of Subtotal 9,	<u>, 937</u> =	994	467	527
<u>1</u>	Total - a,b,c, and d	10.931	5,137	5,794
C	GRAND TOTALS	\$ 20,531	\$5,137	\$ 15,394

Notes:

- (A) 1 Tester @ \$17,000
- (B) 1 Highly skilled @ \$2.40

Sost per piece * \$20,531 = .0027 7,614,000

This operation is not performed separately in the hand process, but is included in steps HW 3 and 4.

Processes Wafer Pattern Printing & Firing Hand No. HW-3 & 4

Based on 2 shifts, 4000 hrs., hourly prod. 1800 and annual prod. 7,200,000

	Annual Cost		
	Total	Fixed	Variable
AW-3	\$26,214.40	\$3,602,63	\$22,511.77
HW-4	9,688.29	1,439.60	8,248.69
	\$ 35,902.69	\$5,042.23	\$30,860.46

Notes:

Cost per piece for HW-3 and $4 = \frac{$35,902.69}{7,200,000} = .00498$

Process Wafer Pattern Printing Hand No. HW-3 Equipment (A) Based on 2 shifts, 4000 hrs., hourly prod. (B) 1800 and annual prod. (B) 7,200,000 Annual Cost Fixed Total Variable 1. Material УX 2. Direct Labor * Hrs. (C) 11,016 x Rate 1.6 \$17,625.60 \$17,625,60 XX 3. Manufacturing Overhead a. Ind. Lab. = 30% 5, 287. 60 \$1,586.30 3,701.30 b. Mach., Equip. & Tool 1,980.40 1,609.08 371.32 c. Occupancy Proc. Space (D) 90 x Ratio 5 = 450 sq. ft. ХX XX $\mathbf{x}\mathbf{x}$ $450 \times .80$ Rent 360.00 360,00 $450 \times .30$ Light 135.00 13,50 121.50 Heat $450 \times .10$ **45.** 00 33, 75 11.25 Subtotal - a, b, and c \$ 7,808.00 d. Miscellaneous = 10% x Subtotal = 780.80 780.80 Total - a, b, c, and d 8,588.80 GRAND TOTALS \$26, 214, 40 \$3,602.63 \$22,611.77 Notes:

- (A) Printing press, screens, bench & stool; cost for 3 stations = \$9,902, 20
- (B) 15 ops. on one side $\times 40 = 600 \text{ ops/hr} \times 4000 \text{ hrs.} = 2,400,000 \text{ ops (pcs)}$ 30 ops. on two sides x 40 = 1200 ops/ $h\tau$ x 4000 hrs. = 4,800,000 ops (pcs) 1800 pcs/hr 7,200,000 pcs annual pro1,
- (C) .546 (Men/hr to make 40 Mod/hr) x 4000 hrs = 2, 184 Dir. Lab. Hrs. 2.208 x 4000 hrs = 8,832
- (D) Based on 30 sq. ft. x 3 Stations (for both Ops) = 90 sq. ft.

Cost per piece = \$26,214.40 = .00364 7,200,000

> This cost is based on printing six wafers at one time instead of one as at present,

PROJECT TINKERTOY Manufacturing Cost	Data		
Process Wafer Pattern Firing	Hand	No. HW-4	
Equipment Curing Oven (A)			
Based on 2 shifts, 4000 hrs., hourly prod. 180	0 and annual	prod. 7,200,	000 (B)
		Annual Cost	
<u>Item</u>	Total	Fixed	Variable
1. Material		хx	
2. Direct Labor = Hrs. 3168 (C) x Rate 1.6 *	\$ <u>5</u> ,068.80	xx	\$5,068.80
3. Manufacturing Overhead a. Indirect Labor	1,520.64	\$ 456,19	1,064.45
b. Mach., Equip. & Tool	2,472.50	827, 75	1,644.75
c. Occupancy = Proc. Space 172 x Ratio 1 = 172 sq.ft. Rent 172 x . 8 =	жж 137, 60	жж 137, 60	хх
$\begin{array}{ccc} \text{Light} & 172 \times .3 & = \\ \text{Heat} & 172 \times .1 & = \end{array}$	51.60 17.20	5. 16 12. 90	46,44 4,30
Subtotal - a,b, and c	\$4,199.54	14, 70	4,30
d. Miscellaneous = 10% x Subtotal	419.95		419.95

Notes:

- (A) Cost of equipment = \$4,730
- (B) 45 Wafers/module x 40 modules/hr = 1800 hrly prod. x 4,000 = annual prod.

4,619.49

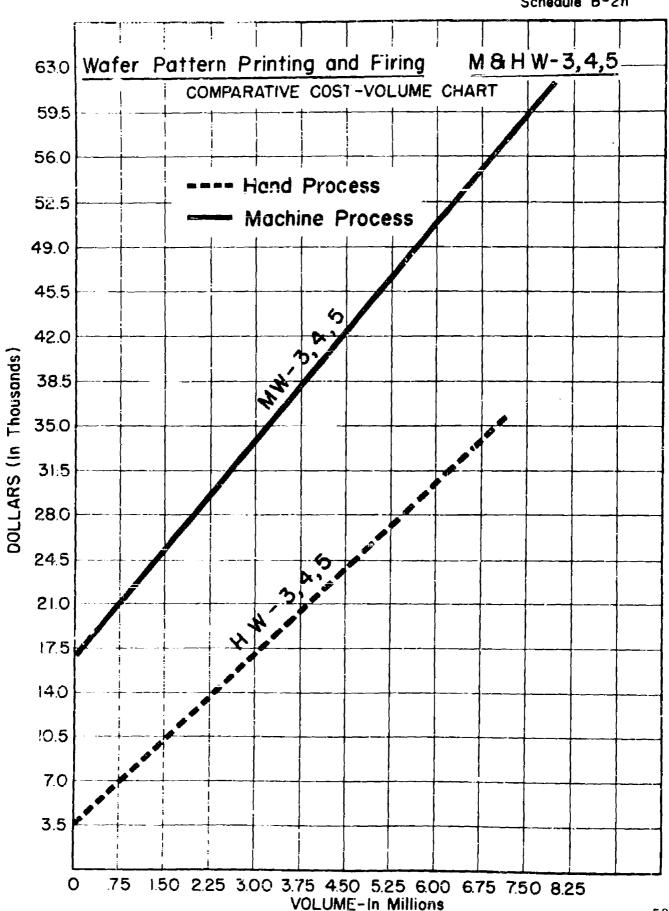
\$9,688.29

(C) .7920 men per hr. per 40 strips x 4000 hrs. = 3,168

Total - a, b, c, and d

GRAND TOTALS

\$1,439.60 \$8,248.69



58

Process Resistor Tape Application Mach. No. MR-1

Equipment 1 Resistor Tape Applicator (A)

Based on 2 shifts, 2,273 hrs., hourly prod. 1,069 and annual prod. 2,430,000

		Annual Co	st
	Total	Fixed	Variable
1. Material		xx	
2. Direct Labor = Hrs. 2,880 x Rate 1.60 (B) =	\$ 4,608	xx	\$4,608
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 4,608 =	1,382	\$ 415	967
b. Mach., Equip. & Tool c. Occupancy = Proc. Space 24 x Ratio 6 = 144 sq.ft.	4,762	2,541	2,221
Rent $144 \times 1.00 =$ Light $144 \times .30 =$ Heat $144 \times .10 =$	144 43 14	144 4 12	39 2
Subtotal - a,b, and c	\$ 6,345	\$3, 116	\$3,229
d. Miscellaneous = 10% of Subtotal 6.345 =	635	312	323
Total - a, b, c, and d	6,980	3,428	3,552
GRAND TOTALS	\$11,588	\$3,428	\$8,160

Notes:

- (A) 1 Tape Applicator @ \$12,000
- (B) 1 Semi-skilled @ \$1.60

Cost per piece = $\frac{$11,588}{2,430,000}$ = .00477

Processes Resistor Tape Application & Inspec. Hand No. HR-1 & 1b Equipment wafers Based on 2 shifts, 4,000 hrs., hourly prod. and annual prod. 2,400,000 Annual Cost Total Fixed Variable HR-1 \$27,358.19 \$2,238.29 \$25,119.90 HR-1b 29,012.72 2,540.55 26,472.07 Total \$56,370.91 \$4,778.94 \$51,591.97	PROJECT TINKERTOY M	anufacturing Co	st Data		
Wafers Based on 2 shifts, 4,000 hrs., hourly prod. Annual Cost Total Fixed Variable HR-1 \$27,358.19 \$2,238.29 \$25,119.90 HR-1b 29,012.72 2,540.65 26,472.07 Total \$56,370.91 \$4,778.94 \$51,591.97	Processes Resistor Tape Ap	plication & Insp	ec. Hand	No. HR	-1 & 1b
Based on 2 shifts, 4,000 hrs., hourly prod. and annual prod. 2,400,000 Annual Cost Total Fixed Variable HR-1 \$27,358.19 \$2,238.29 \$25,119.90 HR-1b 29,012.72 2,540.55 26,472.07 Total \$56,370.91 \$4,778.94 \$51,591.97	Equipment				
Total Fixed Variable HR-1 \$27,358.19 \$2,238.29 \$25,119.90 HR-1b 29,012.72 2,540.55 26,472.07 Total \$56,370.91 \$4,778.94 \$51,591.97	Based on 2 shifts, 4,000 hrs.	, hourly prod.	and	annual pro	
HR-1 \$27,358.19 \$2,238.29 \$25,119.90 HR-1b 29,012.72 2,540.55 26,472.07 Total \$56,370.91 \$4,778.94 \$51,591.97				Annual Co	st
HR-1b 29,012.72 2,540.65 26,472.07 Total \$56,370.91 \$4,778.94 \$51,591.97			Total	Fixed	Variable
HR-1b 29,012.72 2,540.55 26,472.07 Total \$56,370.91 \$4,778.94 \$51,591.97					
Total \$56,370.91 \$4,778.94 \$51,591.97		HR - 1	\$27,358.19	\$2,238.2	9 \$ 25,119.90
		HR - 1b	29,012.72	2,540.5	26,472.07
Notes:		Total	\$ 56, 370. 91	\$ <u>4,778.9</u>	4 \$51,591.97
Notes:					
Notes:					
	Notes:				

\$56,370.91 2,400,000 wafers

= 0.0235

Cost per piece -

PROJE	CT TINKERTOY Manufacturing Cos	t Data		
Proces	ses Resistor Tape Application	Hand	No. HR-	1
Equipm	nent (A)			
Based	on 2 shifts, 4,000 hrs., hourly prod.	B) and annual p	orod. (C) 2,	60,000
		<u>A</u>	nnual Costs	-
	<u>Item</u>	Total	Fixed	Variable
l. Mate	erial		жx	
2. Dire	ect Labor =			
Hr	s. (D) 12, 563.2 x Rate 1.6	\$ 20, 101, 12	хx	\$20,101.12
	ufacturing Overhead			
	d. Lab. = 30% of Dir. 20, 101.12 =		\$1,809.10	
	fach., Equip. & Tool	27.00	21.94	5.06
	ccupancy =	•.		
	Proc. Space (E) 90 x Ratio $5 = \frac{450}{5}$ sq. f		2/2 22	
	Rent 450 x .8 =	360.00	360.00	121 50
	Light 450 x .3 = Heat 450 x .1 =	135.00	13.50	121.50
	Heat 450 x .1 =	45.00	33. 75	11.25
	Subtotal - a, b, and c	6, 597. 34		
d. M	liscellaneous =			
	10% of Subtotal 6,597.34 =	659.73		659.73
	Total - a, b, c, and d	7, 257, 07		
	GRAND TOTALS	\$27,358.19	\$2,238.29	\$25,119.90
Notes:	(A) Bench, stool, cutting tools; cost if	for 3 stations -	\$135.00	
	(B) Use net 600 for comparative cost		4 133.00	
	(C) II op's. on one side $\times 40 = 440/1$. 760, 000	
	5 op's. on two sides x 40 = 200/1	hr. x 4,000 =	800,000	
		2	,560,000 pcs	. annual prod.
	(D) 1.9008 (men/hr. to make 40 mod			
	1.240	x 4,000 1	ars. = 4,960.	
	(E) Based on 30 sq. ft. per station x	3 stations = 90	12,563. sq. ft.	2
	Cost per piece = \$27,358.19 = .01 2,560,000	07		

No.

Hand

HR-la

PROJECT TINKERTOY -- Manufacturing Cost Data

Proces: Curing Resistor Tape

Troces Ouring Resistor Tape	4 41% \$4.00		
Equipment *			
Based on 2 shifts, 4000 hrs., hourly prod. 600	and annual p	rod. 2,400,	000
		Annual Cos	ts
	Total	Fixed	Variable
1. Material		xx	
2. Direct Labor =	\$1,802.24	ХX	\$1,802.24
Hrs. 1, 126. 40 x Rate 1.6 =	\$1,600,24	**	\$1,002,24
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 1,802.24 =	540, 67	\$ 162. 20	378.47
b. Mach., Equip. & Tool	805.00	269. 50	535.50
c. Occupancy =			
Proc. Space 56 x Ratio 5 = 280 sq. ft.			
Rent . 8 x 280 *	224.00	224.00	
Light	84.00	8.40	75.60
Heat .1 x 280 =	28.00	21,00	7,00
Subtotal - a,b, and c	\$1,681.67		
d. Miscellaneous =			
10% x Subtotal 1,681.67 =	168, 17		168.17
Total - a, b, c, and d	1,849.84		
GRAND TOTALS	\$3,652.08	\$ <u>685.10</u>	\$2,966.98

Notes:

* Curing oven (used for other curing opers.; cost distr. on basis of pieces)

15 ops x 40 = hrly prod x 4,000 = 2,400,000 annual prod.

 $.28160 \times 4,000 = 1,126.40 \text{ Dir. Lab. Hrs.}$

Cost per piece = \$3,652.08 = .00152 2,400,000 pcs.

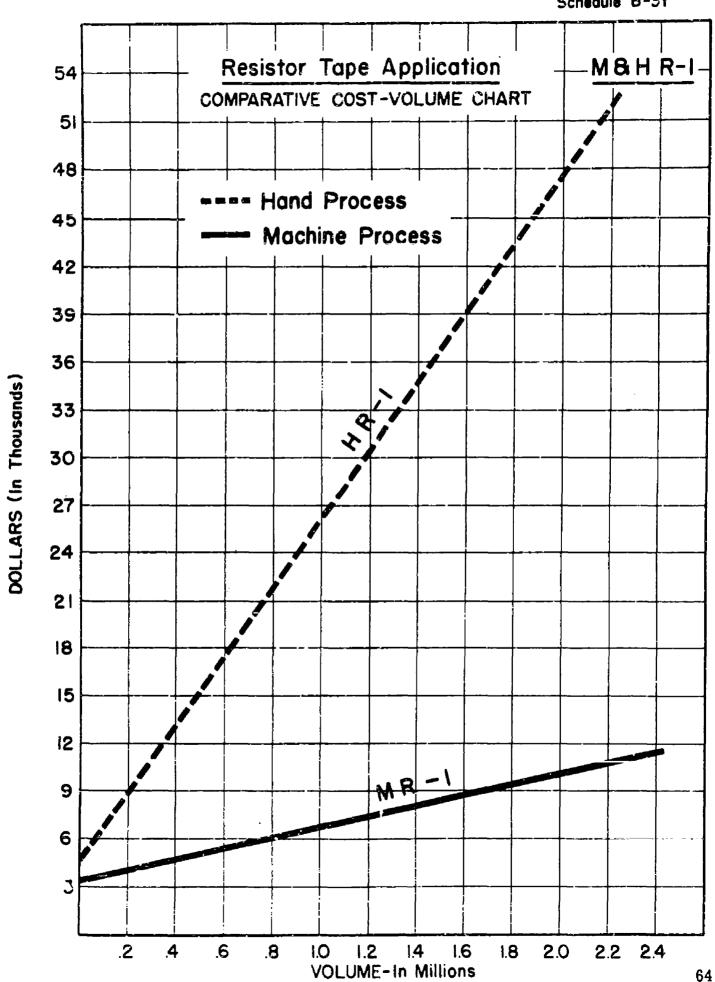
This operation is being performed in current model shop manufacture, but is not included in the projected hand process manufacture. The protective tape curing operation (HR-3) is included.

4

Processes Inspecting Resistor Tape	Hand	No. HR	- 1b
Equipment Benches, stools, elect, testing instr.			
Based on 2 shifts, 4,000 hrs., hourly prod. 60 (640 Insp			0,000 (B) O Inspections)
		Annual Cos	<u>st</u>
	Total	Fixed	Variab!e
1. Material		xx	
2. Direct Labor =			
Hrs. $13,200$ (C) x Rate 1.6	\$21,120.00	xx	\$21,120.00
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 21,120.00 =	6,336.00	\$ 1,900.80	4,435.20
b. Mach., Equip. & Tool	119. 20	96.85	22.35
c. Occupancy = Proc. Space 120 (D) x Ratio 5 = 600 Sq. ft	_		
Rent $.8 \times 600$ = Light $.3 \times 600$ =	480.00	480,00	1/3 00
Light .3 x 600 = = = = = = = = = = = = = = = = = =	180. 00 60. 00	18, 00 45, 00	162.00 15.00
Subtotal - a, b, and c	7, 175. 20		
d. Miscellaneous ≈			
$10\% \times \text{Subtotal } 7,175.20 =$	717, 52		717.52
Total - a,b,c, and d	7,892.72		
GRAND TOTALS	\$ 29, 012, 72	\$2,540.65	\$26,472.07
Notes:			

- (A) Cost of equipment for 4 stations = \$596.
- (B) $15 \text{ ops } \times 40 = 600 \text{ hrly prod } \times 4,000 = 2,400,000 \text{ annual prod.}$
- (C) $3.30 \times 4,000 = 13,200 \text{ Dir. Lab. Hrs.}$
- (D) 4 stations x 30 sq. ft. = 120 sq. ft.

Cost per piece = \$29,012.72 = .0121 2,400,000



Process Protective Tape Application Mach. No MR-2

Equipment 1-Protective Tape Applicator (A)

Based on 2 shifts, 2275 hrs., hourly prod. 1069 and annual prod. 2,430,000

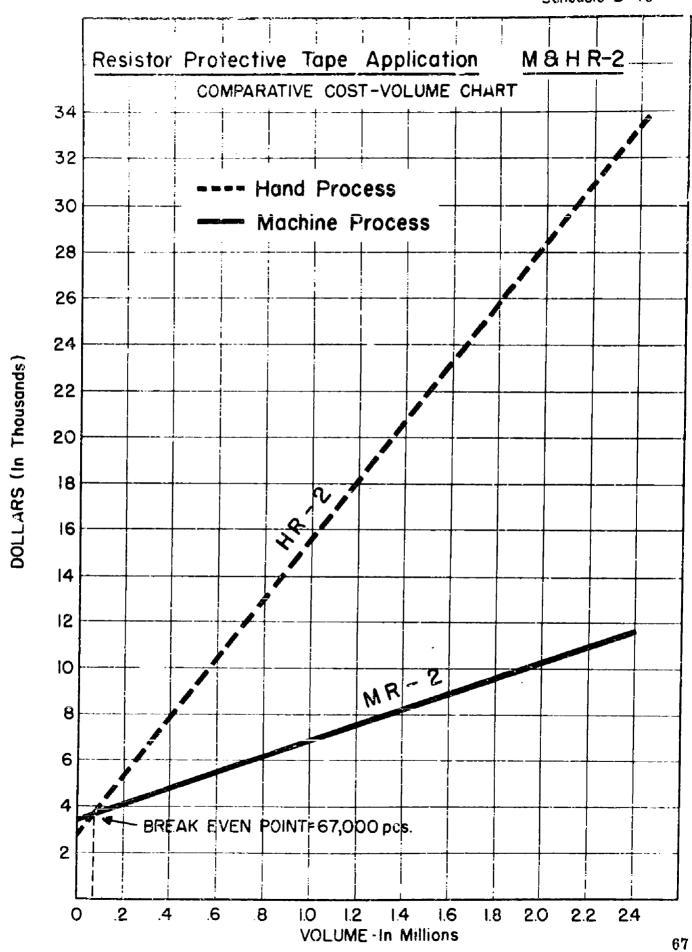
		Annual Cost	•
	Total	Fixed	Variable
1. Material		XX	
2. Direct Labor = Hrs. 2,880 x Rate 1.60 (B) =	\$ 4,608.00	xx	\$4,608.00
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 4,608 =	1,382.00	\$ 415.00	967.00
b. Mach., Equip. & Tool	4,762.00	2,541.00	2,221.00
c. Occupancy = Proc. Space 24 × Ratio 6 = 144 sq. ft. Rent 1.00 × 144 = Light .30 × 144 = Heat .10 × 144 =	144.00 43.00 14.00	=	39.00 2.00
Subtotal - a, b, and c	\$ 6,345.00	\$3,116.00	\$3,229.00
d. Miscellaneous = 10% x Subtotal 6,345 =	635.00	312,00	323.00
Total - a, b, c and d	6,980.00	3,428,00	3,552.00
GRAND TOTAL	\$11,588.00	\$3,428.00	\$8,160.00

Notes:

- (A) 1 Tape applicator = \$12,000
- (B) 1 Semi-skilled = \$1.60

Cost per piece = \$11,588 = .00477 2,430,000

PROJEC	CT TINKERTOY Manufacturing Cos	st Data			
Process	s Resistor Protective - Tape Applica	tion Hand	No. HR-2		
Equipm	ent (A)				
Based o	on 2 shifts, 4000 hrs., hourly prod. (I	3) 600 and annu	al prod. 2,4	00,000 (B)	
			Annual Cost	. s	
		Total	Fixed	Variable	
l. Mate	erial		xx		
2. Dire	ct Labor =				
Н	rs. (C) 15,488 x Rate $1.6 =$	\$24,780.80	xx	\$24,780.80	
3. Mani	ufacturing Overhead				
	ad. Lab. = 30%	7,434.24	\$2,230.27	5,203.97	
b, M	ach., Equip. & Tool	49. 20	39. 98	9.22	
	ccupancy = roc. Space (D) 120 x Ratio 5 = 600 sq. Rent .80 x 600 =	ft. 480, 00	4 80.00	• # n	
	Light 30×600 =	180.00	18,00	162.00	
	Heat .10 x 600 =	60.00	45.00	15, 00	
	Subtotal - a,b, and c	\$ 8,203.44			
d. M	liscellaneous = 10% x Subtotal	820.34		820, 34	
	Total - a, b, c, and d	9,023.78			
	GRAND TOTAL	\$33,804.58	\$2,813.25	\$30,991.33	
Notes: (A) Tape Press, Bench, Stool; cost for 4 stations = \$246, 40 (B) 7 operators on one side x 40 = 280 x 4000 = 1,120,000 8 operators on two sides x 40 = 320 x 4000 = 1,280,000					
	(0) 202002 (22)	,,		4) Labor	
	(D) Based on 30 sq. ft. per station x	4 stations = 12	0 sq. ft.		
	Cost per piece = \$33,804.				



Process Resistor and Protective Tape Curing	Mach.	No. MR	-3
Equipment 1 Oven (A)			
Based on 2 shifts, 2,273 hrs., hourly prod. 1	, 069 and ann	ial prod. 2,4	430,000
		Annual Co	<u>st</u>
	Total	Fixed	Variable
1. Material		XX	
2. Direct Labor = Hrs. (B) x Rate =		х×	
3. Manufacturing Overhead a. Ind. Lab. =% of Dir. =			
b. Mach., Equip. & Tool	\$2,588	\$1,628	\$ 960
c. Occupancy = Proc. Space 60 x Ratio 6 = 360 sq. ft.			
Rent 360 x 1,00	360	360	~
$Light 360 \times .30 =$	108	11	97
Heat $360 \times .10$ =	36	27	9
Subtotal - a, b, and c	\$3,092	\$2,026	\$1,066
d. Miscellaneous =			
$10\% \approx \text{Subtotal } \underline{3,092} =$	309	203	106
Total - a, b, c, and d	-		-

\$3,401

\$2,229

Notes:

- (A) 1 Oven = \$9,000
- (B) Direct Labor included in MR-2

Cost per piece =
$$\frac{$3,401}{2,430,000}$$
 = .00141

GRAND TOTALS

\$1,172

PROJECT	TINKERTOY		Manufacturing	Cost	Data
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Processes Curing Protective Tape	Hand	No. HR-	3
Equipment Oven (A)			
Based on 2 shifts, 4,000 hrs., hourly prod. 60		annual prod	
		Annual Cos	t
	Total	Fixed	Variable
1. Material		xx	
2. Direct Labor = Hrs. 1,126.40 (C) x Rate 1.6 =	\$1,802.24	хх	\$1,802.24
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 1,802.24 =	540.67	\$ 162.20	378 . 47
b. Mach., Equip. & Tool	805.00	685.30	119.70
c. Occupancy = Proc. Space 56 * x Ratio 5 = 280 sq. ft.	224.00	224 00	
Rent $280 \times .8 =$ Light $280 \times .3 =$	224.00 84.00	224, 00 8, 40	75, 60
Heat $\frac{280 \times 1}{280 \times 1}$	28.00	21.00	7, 00
Subtotal - a, b, and c	\$1,681.67		
d. Miscellaneous = 10% x Subtotal 1,681.67 =	168.17		168.17
Total - a, b, c, and d	1,849.84		
GRAND TOTALS	\$3,652.08	\$1,100.90	\$2,551.18

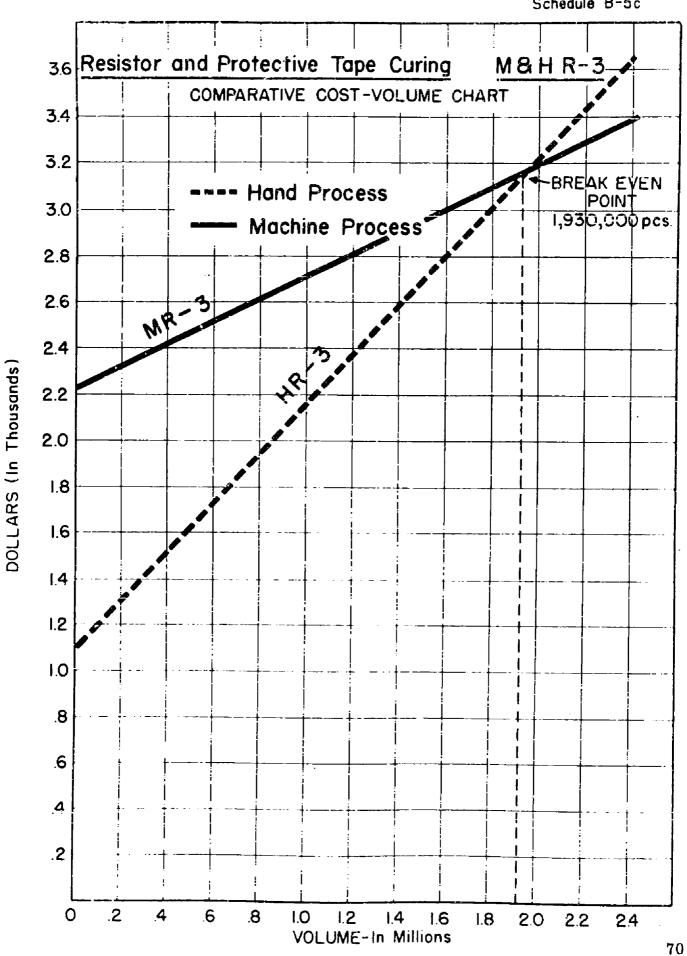
Notes:

* Pro Rata

- (A) Cost of Equipment = \$1,540
- (B) 16 opers \times 40 = 640 hrly. prod. \times 4,000 = 2,560,000 annual prod. (ops.)
- (C) $.28160 \times 4,000 = 1,126.40 \text{ Dir. Lab. Hrs.}$

\$3,652.08 = .00143Cost per operation . 2,560,000 ops

Cost per wafer \$3,652.08 = .001522,400,000 wafers



Process Resistor Wafer Notch Solder Filling Mach. No. MR-4

Equipment 2 Notch Tinners (A)

Based on 2 shifts, 2,978 hrs., hourly prod. 816 and annual prod. 2,430,000

		Annual Cos	sts
	Total	Fixed	Variable
l. Material		жx	
2. Direct Labor = Hrs. 3,600 x Rate 2.40 (B) =	\$ 8,640	xx	\$ 8,640
 Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 8,640 = 	2,592	\$ 778	1,814
b. Mach., Equip. & Tool	4,743	2,435	2,30s
c. Occupancy = Proc. Space 50 x Ratio 6 = 300 sq. ft. Rent 300 x 1.00 = Light 300 x .30 = Heat 300 x .10 =	300 90 30	300 9 24	81
Subtotal - a,b, and c	\$ 7,755	\$3,546	\$ 4,209
d. Miscellaneous = 10% x Subtotal 7,755 =	776	355	421
Total - a, b, c, and d	8,531	3,901	4,630
GRAND TOTALS	\$17,171	\$3, 901	\$ 13,270

Notes:

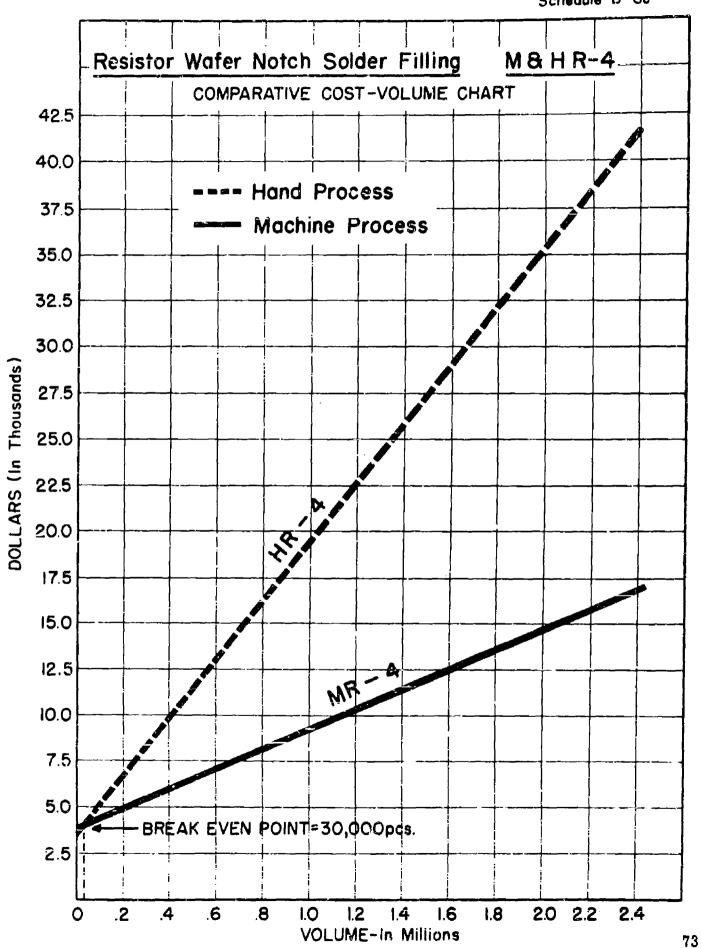
- (A) 2 Tinners @ \$5,750 = \$11,500
- (B) 2 Unskilled @ \$1.20 = \$2.40

Cost per piece = $\frac{$17,171}{2,430,000}$ = .00707

Process Resistor-Wafer Notch Solder Filling	Hand	No. HR-4	
Equipment (A)			
Based on 2 shifts, 4000 hrs., hourly prod. 600	and annual p	rod. 2,400,0	000 (B)
		Annual Cost	:s
	Total	Fixed	Variable
1. Material		жж	
2. Direct Labor =			
Hrs. 19,008 (C) x Rate 1.6 =	\$30,412.80	XX	\$30,412.80
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 30,412.80	9, 123. 84	\$2,737.15	6,386.69
b. Mach., Equip. & Tool	187.60	152.43	35.17
c. Occupancy = Proc. Space 150 (D) x Ratio 5 = 750 sq. Rent . 8 x 750 =	ft. 600.00	600.00	
Light	225.00	25.00	200.00
Heat <u>1 x 750</u> •	75.00	56.25	18.75
Subtotal - a,b, and c	\$10,211.44		
d. Miscellaneous = 10% x Subtotal 10,211.44 =	1,021.14		
Total - a, b, c, and d	11,232.58	**************	
GRAND TOTALS	\$41,645.38	\$3,570.83	\$38,074.55

Notes:

- (A) Solder pots, cleaning & rinsing pans, bench, stool, tweezers, hood. Cost of equipment \$938.
- (B) $15 \text{ ops } \times 40 = 600/\text{hr } \times 4,000 = 2,400,000$
- (C) $4.752 \times 4,000 = 19,008 \text{ Dir. Lab. Hrs.}$
- (D) 5 stations x 30 sq. ft. = 150 sq. ft.



Process Resistor Inspection	Mach.	No. MR	-5
Equipment 2 Resistor Assembly Testers (A)	- -		
Based on 2 shifts, 2,490 hrs., hourly prod. 97	6 and annual	prod. 2,430	0,000
		Annual Cos	st
	Total	Fixed	Variable
l. Material		ХX	
2. Direct Labor = Hrs. 3,086 x Rate 4.80 (B) =	\$14,784	xx	\$14,784
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 14,784	4,435	\$1,331	3,104
b. Mach., Equip. & Tool	8,821	4,658	4,163
c. Occupancy = Proc. Space 82 x Ratio 6 = 492 sq. ft. Rent 492 x 1.00 = Light 492 x .30 = Heat 492 x .10 =	492 148 49	492 15 36	133 13
Subtotal - a, b, and c	\$13,945	\$ 6,532	\$ 7,413
d. Miscellaneous = 10% x Subtotal 13,945 = Total - a, b, c, and d	1,395 15,340	653 7,185	742 8,155
	· -		

\$30,124

\$7,185

Notes:

- (A) 2 Testers @ \$11,000 = \$22,000
- (B) 2 Highly Skilled @ \$2.40 = \$4.80

GRAND TOTALS

Cost per piece =
$$\frac{$30,124}{2,430,000}$$
 = .0124

\$22,939

No. HR-5

Hand

PROJECT T	TINKERTOY	٠	Manufacturing	Cost	Data
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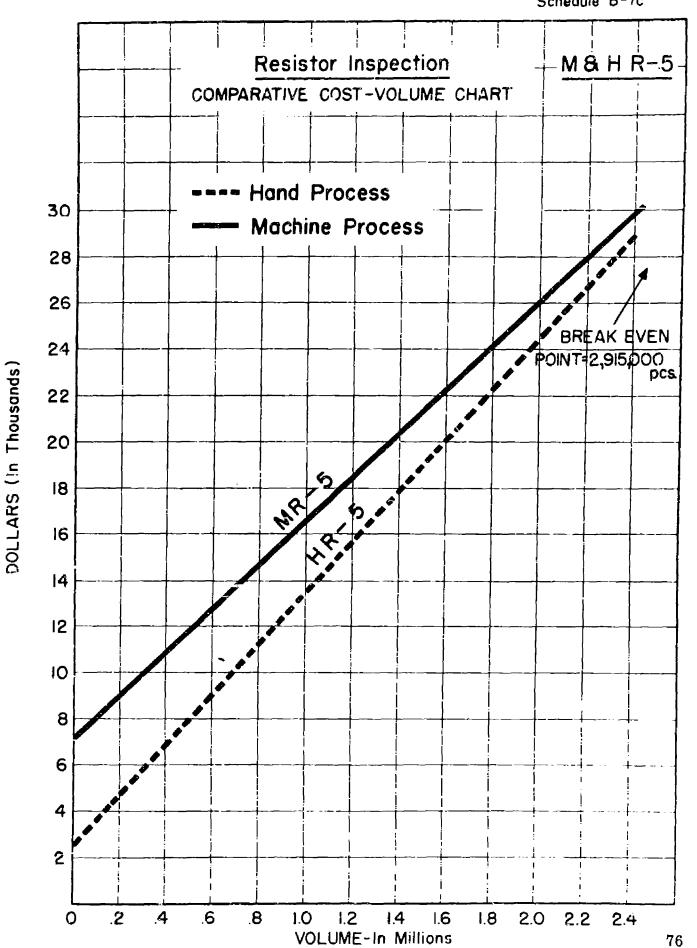
Process Resistor Inspection

Equipment Benches, stools, testing equipment	<u>t</u>		
Based on 2 shifts, 4000 hrs., hourly prod. 600	and annual p	rod. 2,400,	000
		Annual Cost	<u>t</u>
	<u>Total</u>	Fixed	Variable
1. Material		жx	
2. Direct Labor = Hrs. 13,200 x Rate 1.6 =	\$21,120.00	xx	\$21,120.00
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 21,120.00	6, 336. 00	\$1,900.80	4,435,20
b. Mach., Equip. & Tool	95.40	77,51	17.89
c. Occupancy = Proc. Space 120 x Ratio 5 = 600 sq. ft. Rent .8 x 600 =	486.00	480.00	
Light .3 x 600 = Heat .1 x 600 =	180.00 60.00	18,00 4 5,00	162.00 15.00
Subtotal - a,b, and c	\$ 7,151.40		
d. Miscellaneous = 10% of Subtotal 7,151.40	715, 14		715.14
Total - a, b, c, and d	7,866.54		
GRAND TOTALS	\$28,986.54	\$2,521,31	\$26,465.23

Notes:

15 ops x 40 = 600 ops/m x 4,000 = 2,400,000 annual prod. 3,3 x 4,000 = 13,200 Dir. Lab. Hrs. 4 stations x 30 sq. ft. = 120 Cost of equipment = \$477

Cost per piece = $\frac{$28,986.54}{2,400,000}$ = .0121



Process Capacitor Wafer Pattern Tinning	Mach.	No. MC	- 1
Equipment 3-Surface Tinners (A)	_		
Based on 2 shifts, 4000 hrs., hourly prod. 12	276 and annual	prod. 5,18	4,000 (B)
		Annual Co	st
	Total	Fixed	Variable
1. Material	0	xx	~ **
2. Direct Labor =			
Hrs. $\frac{4000}{100}$ x Rate $\frac{4.80}{100}$ =	\$19,200	xx	\$19,200
3. Manufacturing Overhead			
a. Ind. Lab. = 30% of Dir. 19,200 =	5,760	\$1,728	4,032
b. Mach., Equip. & Tool	3,732	3,420	312
c. Occupancy =			
Proc. Space 66 x Ratio 6 = 396 sq. ft.			
Rent 396 x 1.00 = Light 396 x .30 =	396	396	107
Heat $396 \times .30 =$	119 4 0	12 30	107 10
770			
Subtotal - a, b, and c	\$10,047	\$ 5,586	\$ 4,461
d. Miscellaneous =			
10% x Subtotal 10,047 =	1,005	559	446
Total - a, b, c, and d	11,052	6,145	4,907
GRAND TOTALS	\$30,252	\$6,145	\$24,107

Notes:

- (A) 3-Surface Tinners @ \$7,600 for capacitor and tube socket pattern tinning.
- (B) This total is composed of:

Capacitor wafers = 3,390,000

Tube socket wafers = 1,794,000

(C) 3 Semi-skilled @ \$1.60 = \$4.80

Cost per piece = $\frac{$30,252}{5,184,000}$ = .00584

\$29,399.00

6, 173, 79

35, 17

Process Capacitor Wafer Pattern Tinning Hand No. HC-1

Equipment (A)

Based on 2 shifts, 4000 hrs., hourly prod. 720 (B) and annual prod. 2,880,000

Annual Cost

Total Fixed Variable

1. Material ***xx**

2. Direct Labor =

\$29,399.00

187.60

\$40,297.03

хx

152.43

\$3,477.09

8,819.70 \$2,645.91

PROJECT TINKERTOY -- Manufacturing Cost Data

Hrs. 18,374 (C) x Rate 1.6 =

a. Ind. Lab. = 30% of Dir. 29,399 =

3. Manufacturing Overhead

b. Mach., Equip. & Tool

•				
c. Occupancy	y =			
Proc. Spa	ice 150 (D) x Ratio 5 = 750 sq.	ft,		
Rent	.80 x 750	600.00	600 .00	
Light	$.30 \times 750 =$	225.00	22.50	202,50
Heat	.10 x 75Q =	75.00	56.25	18.75
	Subtotal - a,b, and c	\$ 9,907.30		
d. Miscellan 10% x 8	eous = Subtotal 9,907.30 =	990. 73	www.	990.73
	Total - a.b.c and d	10.898.03		

Notes: (A) Solder pots, tweezers, overhead hood, bench and stool.

Cost for 5 stations = \$938.

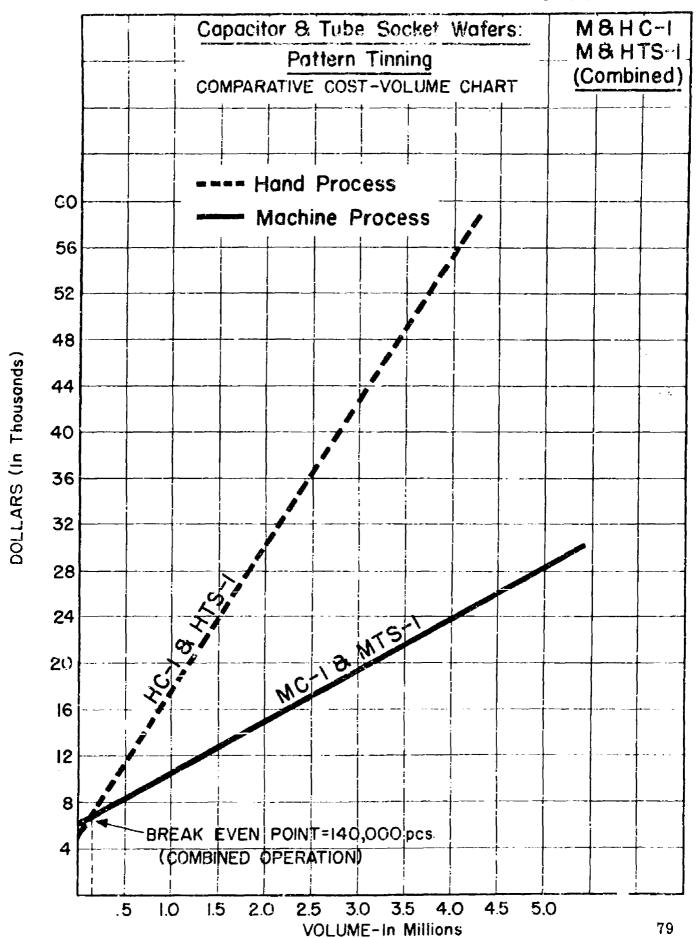
(B) 18 wafers/module x 40 modules/hr = 720/hr

GRAND TOTALS

- (C) 4.5936 men/hr for 40 modules/hr x 4000 hrs = 18,374 hrs
- (D) 5 stations required @ 30 sq. ft. each = 150 sq. ft.

The following chart, Schedule B-8c, reflects the combined capacitor and tube socket pattern tinning operations. (See B-8a, and B-15a)

\$36,819.94



Processes Capacitor Body Pattern Painting and Firing Mach No. MC-2 & 3

Equipment See MC-2 & 3 Data Sheets

Based on 2 Shifts, 3840 Hrs., Hourly prod. 1350 and annual prod. 5, 184,000 bodies

			Annual Costs	-
		Total	Fixed	Variable
	MC-2	\$26.493.00	\$6,348.00	\$20,145.00
	MC - 3	5,258.00	2,724.00	2,534.00
TOTAL		\$31,751.00	\$9,072.00	\$22 ,679. 0 0

Notes:

Cost per piece for MC-2 and $3 = \frac{$31,751.00}{5,184,000} = .00612$

Processes Capacitor Body Pattern Painter Mach. MC-2 No.

Equipment 2-Capacitor Body Pattern Painters (A)

Based on 2 Shifts, 3840 Hrs., Hourly Prod. 1350 and annual Prod. 5, 184,000 Bodies

	_	Annual Cost	8
	Total	Fixed	Variable
l. Material		xx	
2. Direct Labor = Hrs. 4000 x Rate 3.80 (B) *	\$12,800	ж	\$12,800
3. Manufacturing Overhead			
a. Ind. Lab. = 30% of Direct \$12,800	3,840	\$1,152	2,688
b. Mach., Equip. & Tool	8, 121	4,234	3,887
c. Occupancy = Proc. space 58 x Ratio 6 = 348			
Rent 348 x \$1.00 =	348	348	
Light '' x .30 =	i 0 4	10	94
Heat " x .10 =	35	27	8
Subtotal - a,b, and c.	12,448	5,771	6,677
d. Miscellaneous =			
10% x Subtotal \$12,448	1,245	577	668
Total - a, b, c, and d	13, 693	6,348	7,345
GRAND TOTALS	\$26,493	\$6,348	\$20, 145

Notes:

- (A) 2 Printers at \$10,000 = \$20,000
- 2 Semi-skilled at \$1.60 = \$3.20 (B)

Cost per piece = \$26,493 .00511

PROJECT THISDRICA	Manactaring Co.			
Processes Capacitor	Body Pattern Firing	Mach.	No. MC	;-3
Equipment 1-Furnac	e (A)			
Based on 2 shifts, 3840	hrs., hourly prod. 13	50 and annual	l prod. <u>5, 184</u>	, 000
		<u>A</u> :	nnual Costs	
<u>Item</u>		Total	Fixed	Variable
1. Material				
2. Direct Labor = (B)				
3. Manufacturing Overla. Ind. Lab.	head			
b. Machine, Equipm	ent & Tool	705, د \$	\$1,628	\$2,077
c. Occupancy = Proc. Space 128 Rent 768 x Light 768 x Heat 768 x	. 30 =	768 230 77	768 23 57	207 20
Subtota	<u>l</u> - a, b, and c	4,780	2,476	2,304
d. Miscellaneous = 10% x Subtotal	4780 =	478	248	230
Total -	a, b, c, and	5,258	2,724	
	GRAND TOTALS	\$ 5,258	\$2,724	\$2,534
Paint Firi	or in Operation MC-2	•	Notch	

Processes Capacitor Body Pattern Printing & Firing Hand No. HC-2, 2a & 3

Equipment See HC-2, 2a & 3 Data Sheets

Based on 2 shifts, 4,000 hrs., hourly prod. 1,360 and annual prod. 5,440,000

	Annual Cost				
	Total	Fixed	<u>Variable</u>		
HC-2	\$ 24, 916. 86	\$3,148.89	\$21,767.97		
HC-2a	6, 586, 72	582. 85	6,003.87		
HC - 3	7, 543. 46	1,417.68	6, 125. 78		
GRAND TOTALS	\$39,047.04	\$5,149.42	\$33,897.62		

Notes:

Cost per piece for HC2, 2a & 3 =

\$39,047.04 - .00717 5,440,000

PROJECT TINKERTOY Manufacturing Cost	Data		
Processes Capacitor Body Pattern Printing	Hand	No. HC	-2
Equipment (A)			
Based on 2 shifts, 4,000 hrs., hourly prod. 1,	360 and annu	al prod. <u>5,4</u>	40,000 (B)
		Annual Cos	<u>:t</u>
	Total	Fixed	Variable
l. Material		ΣХ	
2. Direct Labor = Hrs. 10,662 (C) x Rate 1.6 =	\$ 17,060	хх	\$17,060
3. Manufacturing Overhead a. Ind. Lab. = 30% of Direct 17,060 =	5,118	\$ 1,535,40	3,582.60
b. Mach., Equip. & Tool	1,484.60	1,206.24	278, 36
c. Occupancy = Proc. Space 90 (D) x Ratio 5 = 450 sq. ft. Rent 450 x . 80 = Light 450 x . 30 = Heat 450 x . 10 =	360, 00 135, 00 45, 00	360.00 13.50 33.75	121.50 11.25
Subtotal - a,b, and c	\$ 7,142.60		
d. Miscellaneous = 10% of Subtotal 7,142.60 =	714.26		714.26
Total - a,b,c, and d	7,856.86		

Notes:

- (A) Capacitor Printing Press, Syntron, Rack, Bench & Stool Cost for 3 stations = \$7,423.
- (B) $34 \times 40 = 1,360$ hrly. prod. $\times 4,000$
- (C) $2.66560 \times 4,000 = 10,662$ Dir. Lab. Hrs.

GRAND TOTALS

(D) 3 stations x 30 sq. ft. = 90 sq. ft.

Cost per piece = $\frac{$24,916.86}{5,440,000}$ = .00458

\$24,916.86 \$3,148.89 \$21,767.97

HC-2a Hand No. Processes Make Capacitor Leads Equipment Benches, stools, fixture (A) Based on 2 shifts, 4,000 hrs., hourly prod. 1,360 and annual prod. 5,440,000 (B) Annual Costs Variable Fixed Total 1. Material XX 2. Direct Labor = \$4,787.20 Hrs. 2,992 (C) x Rate 1.6 =\$ 4,787.20 3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 4, 787.20 = 1,436,16 **\$4**30.85 1,005.31 3.75 20.00 16. 25 b. Mach., Equip. & Tool c. Occupancy = Proc. Space 30(D) x Ratio 5 = 150 sq. ft. $150 \times .80$ 120,00 120.00 40.50 4.50 45.00 150 x Light . 30 . 10 11.25 3.75 Heat 150 x 15.00 \$1,636.16 Subtotal - a, b, and c d. Miscellaneous = 163, 36 10% of Subtotal 1,636.15 = 163.36 Total - a, b, c, and d 1,799.52 GRAND TOTALS \$6,586.72 \$582.85 **\$6**,003.87

Notes: (A) Equipment for one station = \$100.

PROJECT TINKERTOY -- Manufacturing Cost Data

(B) $34 \times 40 = 1,360 \text{ hrly. prod. } \times 4,000$

(C) $.74800 \times 4,000 = 2,992 \text{ Dir. Lab. Hrs.}$

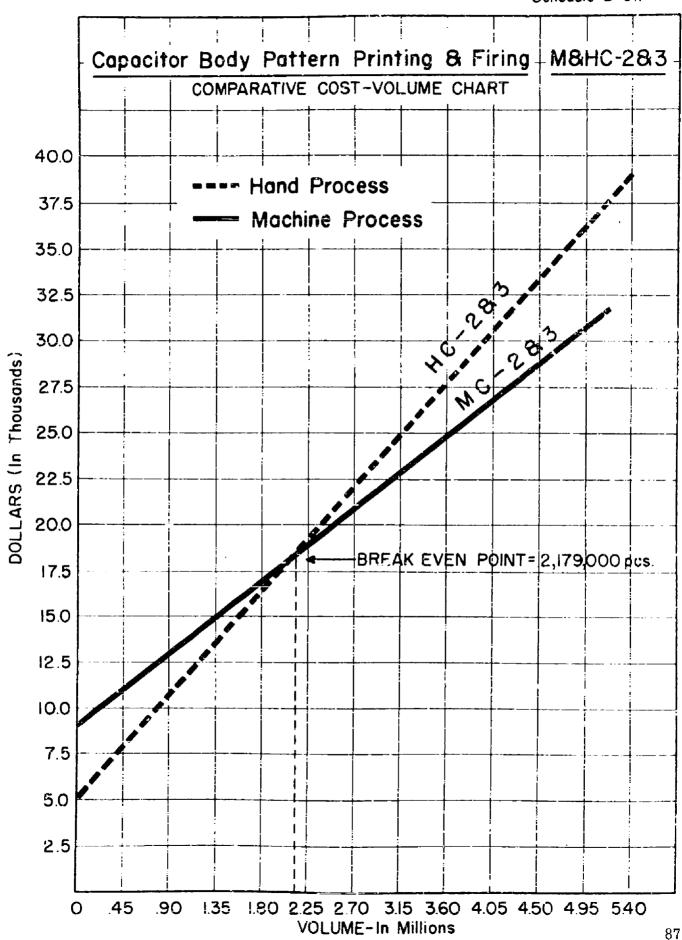
Cost per piece = $\frac{$6,586.72}{5,440,000}$ = .00121

PROJECT TINKERTOY Manufacturing Cost	Data		
Processes Capacitor Body Pattern Firing	Hand	No. HC-	3
Equipment 1 Oven (A)			
Based on 2 shifts, 4,000 hrs., hourly prod. 1	, 360 and ann	al prod. <u>5,4</u>	40,000 (B)
		Annual Cos	<u>it</u>
	Total	Fixed	Variable
l. Material		ж×	
2. Direct Labor • Hrs. 2,323 (C) x Rate 1.6 =	\$3,717.00	xx	\$3,717.00
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 3,717 =	1,115.10	\$ 334,53	780, 57
b. Mach., Equip. & Tool	1,667.50	558, 25	1,109.25
c. Occupancy = Proc. Space 116 (D) x Ratio 5 = 580 sq. f Rent 58 x . 80 - = Light 580 x . 30 =	464.00	464.00	
Heat 580 x . 10 =	174.00 58.00	17. 40 43. 50	156.60 14.50
Subtotal - a,b, and c	\$3,478.60		
d. Miscellaneous = 10% x Subtotal 3,478.60 =	347.86		347. 86
Total - a,b,c, and d	3,826.46		
GRAND TOTALS	\$7,543.46	\$1,417.69	\$6,125.78

Notes:

- (A) 1 oven @ \$3,190.
- (B) $34 \times 40 = 1,360 \times 4,000$
- (C) .58080 x 4,000 = 2,323 Dir. Lab. Hrs.
- (D) This is oven area, in which is included all associated space requirements.

Cost per piece = \$7,543.46 = .00138 5,440,000



Processes Capacitator Body Pattern Testing Mach.

No. MC-4

Equipment 1 Capacitor Body Pattern Tester (A)

Based on 2 shifts, 3,134 hrs., hourly prod. 1,654 and annual prod. 5,184,000

		Annual Costs	
	Total	Fixed	Variable
1. Material		хх	
2. Direct Labor = Hrs. 3,720 x Rate 2.40 (B)	\$8,928	xx	\$8,928
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 8,928 =	2,678	\$ 803	1,875
b. Mach., Equip. & Tool	2,239	1,165	1,074
c. Occupancy = Proc. Space 17 x Ratio 6 = 102 sq.ft.			
Rent 102×1.00 = Light $102 \times .30$ =	102 31	102 3	28
Heat $102 \times .10$	10	9	1
Subtotal - a, b, and c	5,060	\$2,082	\$2,078
d. Miscellaneous = 10% x Subtotal 5,060 =	506	208	298
Total - a, b, c and d	5,566	2,290	3,276
GRAND TOTALS	\$14,494	\$2,290	\$12,204

- Notes: (A) 1 Tester @ \$5,500
 - (B) 1 Highly Skilled @ \$2.40

Cost per piece = \$14,494 5,184,000 .0028

PROJECT TINKERTOY Manufacturing Cost Data			
Processes Capacitor Body Pattern Testing	Hand	No. HC-4	
Equipment Benches, stools, electric tester	(A)		
Based on 2 shifts, 4,000 hrs., hourly prod. 1	, 360 and annua	l prod. 5,44	0,000 (B)
	Annual Costs		
	Total	Fixed	Variable
1. Material		xx	
2. Direct Labor = Hrs. 9,574 (C) x Rate 1.6 =	\$15,319	xx	\$15,319
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 15,319 =	4, 595, 70	\$1,378.71	3,216.99
b. Mach., Equip. & Tool	324.00	263. 25	60.75
c. Occupancy = Proc. Space 90(D) x Ratio 5 = 450 sq.ft. Rent	360.00 135.00 45.00	360.00 13.50 33.75	 121.50 11.25
Subtotal - a, b, and c	5, 459. 70		
d. Miscelianeous = 10% x Subtotal 5,459.70 =	545.97	·	545.97
Total - a, b, c, and d	6,005.67		
GRAND TOTALS	\$21,324.67	\$2,049.21	\$19,275.46

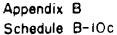
Notes: (A) Equipment for 3 stations = \$1,620

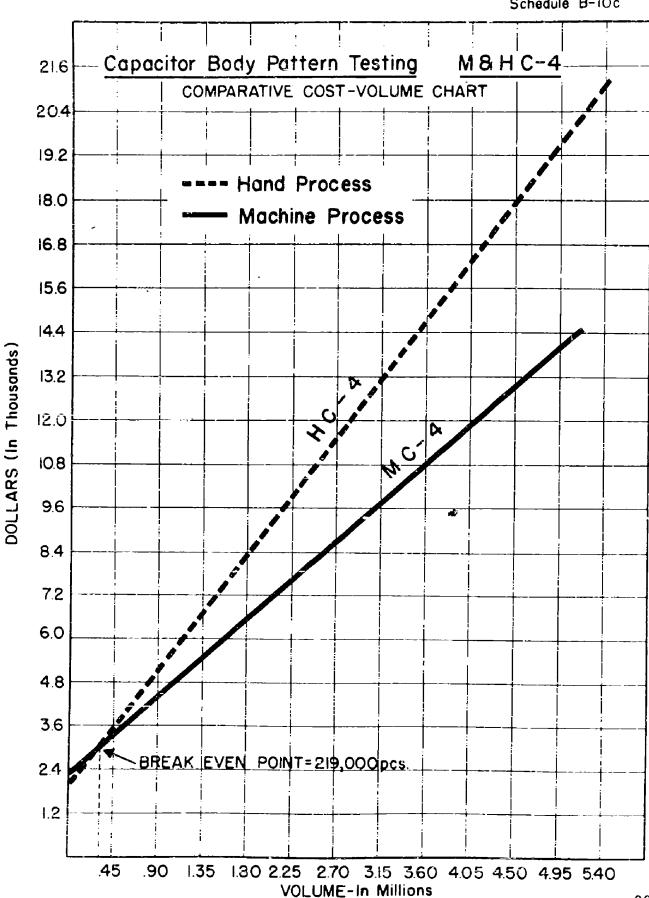
(B) $34 \times 40 = 1,360 \text{ pcs./hr.} \times 4,000 = 5,440,000$

(C) $2.39360 \times 4,000 = 9,574$

(D) 3 stations \approx 30 sq. ft. \approx 90 sq. ft.

Cost per piece = \$21,324.67 = .00392 5,440,000 pcs.





PROJECT	TINKERTOY		Manufacturing	Cost	Data
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Processes Capacitor Body Pattern Tinning Mach, No. MC-5

Equipment 4 Capacitor Body Pattern Timers (A)

Based on 2 shifts, 3,306 hrs., hourly prod. 1,568 and annual prod. 5,184,000

		Annual Cost	
	Total	Fixed	Variable
1. Material		xx	
2. Direct Labor = Hrs. 3, 880 x Rate 6.40 (B) =	\$24,832	xx	\$24,832
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 24,832 =	7,453	\$ 2,236	5,217
b. Mach., Equip. & Tool	12,409	6,436	5,973
c. Occupancy = Proc. Space 92 x Ratio 6 = 552 sq. ft. Rent 552 x 1.00 = Light 552 x .30 = Heat 552 x .10 =	552 166 55	552 17 42	149 13
Subtotal - a,b, and c	\$20,635	\$ 9,283	\$11,352
d. Miscellaneous = 10% x Subtotal 20,635 =	2,064	928	1,136
Total - a, b, c, and d	22,699	10,211	12,488
GRAND TOTALS	\$47,531	\$10,211	\$37,320

Notes:

- 1

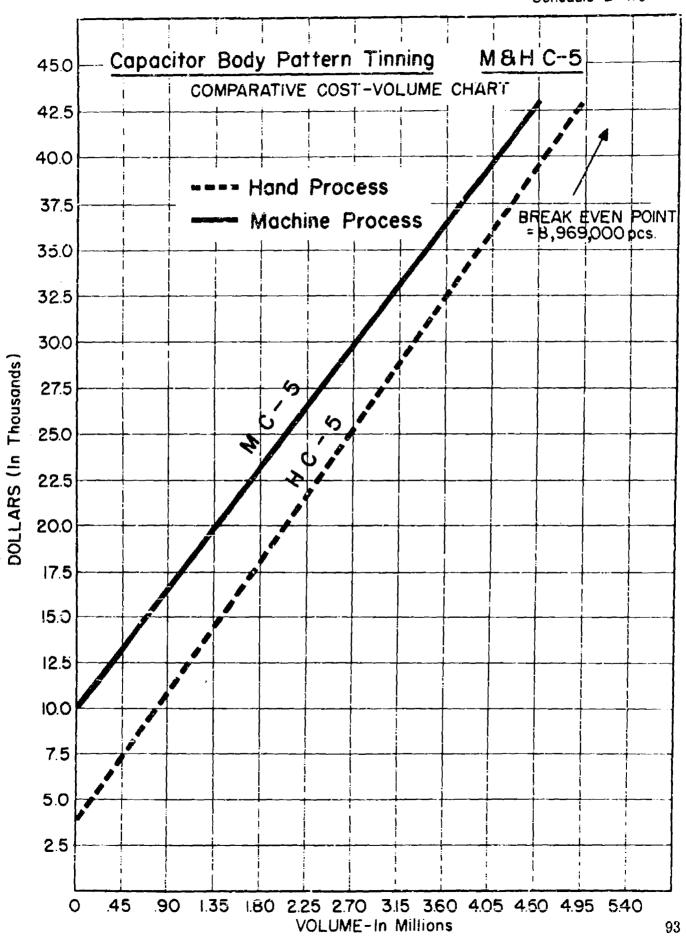
- (A) 4 Timers @ \$7,600 = \$30,400
- (B) 4 Semi-skilled @ \$1,60 * \$6.40

Cost per piece = \$47,531 = .00917 5,184,000

PROJECT TINKERTO1 Manufacturing Cost	Data				
Processes Capacitor Body Pattern Tinning	Hand	No. HC-	5		
Equipment Benches, stools, solder pots, exha	ust hood,& m	isc. (A)			
Based on 2 shifts, 4,000 hrs., hourly prod. 1,360 and annual prod. 5,440,000 (B)					
	Annual Cost				
	Total	Fixed	Variable		
l. Material		хх			
2. Direct Labor = Hrs. 21 524 (C) * Pate 1 6 -	\$34 468 0 0	1***	\$3 4 468 00		
Hrs. $21,524$ (C) x Rate 1.6 =	\$34,468.00	· xx	\$34,468.00		
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 34,468.	10,340.40	\$3,102.12	7,238.28		
b. Mach., Equip. & Tool	187.60	152,43	35, 17		
c. Occupancy = Proc. Space 150 (D) x Ratio 5 = 750 sq. ft.					
Rent 750 x . 8 =	600.00				
Light $\frac{750 \times .3}{750 \times .1} =$	225. 00 75. 00	22, 50 56, 25	202, 50 18, 75		
Subtotal - a, b, and c	\$11,428.00				
d. Miscellaneous =					
$10\% \times Subtotal 11,428 =$	1,142.80		1,142,80		
$\underline{\text{Total}}$ - a, b, c, and d	12,570.80	3,933.30	8,637.50		
GRAND TOTALS	\$47,038.80	\$3,933.30	\$43,105.50		
Notes: (A) Equipment for 5 stations = \$938 (B) 34 x 40 = 1,360 hrly, prod. x 4,0 (C) 5.38560 x 4,000 = 21,542 (D) 5 stations x 30 sq. ft. = 150 sq. f		00			

\$47,038.80 = .00866 5,440,000

Cost per piece .



Processes Capacitor Body to Wafer Assembly Mach. No. MC-6

Equipment 3 Capacitor Assemblers (A)

Based on 2 shifts, 3,923 hrs., hourly prod. 702 and annual prod. 2,754,000

	Annual Cost		
	Total	Fixed	Variable
l. Material		xx	
2. Direct Labor = Hrs. 4,000 x Rate 9.60 (B) =	\$38,400	xx	\$38,400
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. \$38,000 =	11,520	\$ 3,456	8,064
b. Mach., Equip. & Tool	33,237	17,467	15,770
c. Occupancy = Proc. Space 264 x: Ratio 6 = 1,584 sq. ft. Rent 1584 x 1.00 =	1,584	1,584	
$\begin{array}{cccc} \text{Light} & \overline{1584 \times .30} & = \\ \text{Heat} & \overline{1584 \times .10} & = \end{array}$	475 158	48 120	±27 38
Subtotal - a,b, and c	\$ 46,974	\$22,675	\$24,299
d. Miscellaneous = 10% x Subtotal 46,074 =	4,697	2,268	2,429
Total - a, b, c, and d	51,671	24, 943	26,728
GRAND TOTALS	\$90,071	\$24,943	\$65,128

Notes:

- (A) 3 Assemblers @ \$27,000 = \$82,500
- (B) 6 Semi-skilled @ \$1,60 = \$9.60

Cost per piece = $\frac{$90,071}{2,754,000}$ = .0327

Processes Assem. Capacitor Body to Wafer,

No. H.C-6, 6a, 6b, 6c

Assem. Leads, Subassem. Cap., and Apply Protective Coating

Hand

Based on 2 shifts, 4,000 hours and annual production 2,880,000 wafers

	Total	Fixed	Variable
нс-6	\$50,136.08	\$4,275.72	\$45,860.36
HC-6a	86,203.49	7, 126. 95	79,076.54
НС-6Ь	17,060.54	1, 454. 98	15,605.56
HC-6c	82,801.72	6,875.95	75,925.77
GRAND TOTALS	\$236,201.83	\$19,733.60	\$216, 468. 23

Notes: Cost per piece = \$236,201.83 = .082

95

b. Mach., Equip. & Tool 201.80 163.96 37.84 c. Occupancy = Proc. Space(D) 180 x Ratio 5 = 900 sq.ft. Rent 900 x .8 = 720.00 720.00 Light 900 x .3 = 270.00 27.00 243.00	Processes Capacitor Body to Wafer Assembly	Hand	No. HC-6	
Annual Costs Total Fixed Variable	Equipment (A)			
Total Fixed Variable	Based on 2 shifts, $4,000$ hrs., hourly prod. (B) 760 and annu	al prod. (B)	3,040,000
1. Material			Annual Costs	
2. Direct Labor = (C)22,897 x Rate 1.6 = \$36,636.16 xx \$336,636.16 3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 36,636.16 = 10,990.85 \$3,297.26 7,693.59 b. Mach., Equip. & Tool 201.80 163.96 37.84 c. Occupancy = Proc. Space(D) 180 x Ratio 5 = 900 sq. ft. Rent 900 x .8 = 720.00 720.00 Light 900 x .3 = 270.00 27.00 243.00 Heat 900 x .1 = 90.00 67.50 22.50 Subtotal - a, b, and c 12,272.65 d. Miscellaneous = 10% x Subtotal 12,272.65 = 1,227.27 1,227.27 Total - a, b, c, and d 13,499.92 GRAND TOTALS \$50,136.08 \$4,275.72 \$45,860.36 Notes: (A) Solder pots, cleaning and rinsing pots, tweezers, bench and stool; cost for 6 stations = \$1,008.70 (B) 4 (.02 & .01) cap's x 40 = 160 pcs/hr x 4,000 = 640,000 8 (two .01) " x 40 = 320 " x 4,000 = 1,120,000 7 (one .01) " x 40 = 280 " x 4,000 = 1,120,000 7 (one .01) " x 40 = 280 " x 4,000 = 1,120,000 7,000 annual prod. (C) 2.112 (men/hr to make 40 mod/hr) x 4,000 hrs = 8,448.00 dir. lab. hrs. 2.288 (") x 4,000 = 9,152.00 " 1.3244 (") x 4,000 = 5,297.60 " (D) Based on 30 sq. ft. x 6 stations = 130 sq. ft. Cost per piece = \$50,136.08 = .0165 96		Total	Fixed	Variable
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 36, 636.16 = 10,990.85 \$3,297.26 7,693.59 b. Mach., Equip. & Tool 201.80 163.96 37.84 c. Occupancy = Proc. Space(D) 180 x Ratio 5 = 900 sq.ft. Rent 900 x .3 = 720.00 720.00 Light 900 x .3 = 270.00 27.00 243.00 Heat 900 x .1 = 90.00 67.50 22.50 Subtotal - a, b, and c 12,272.65 d. Miscellaneous = 10% x Subtotal 12,272.65 = 1,227.27 1,227.27 Total - a, b, c, and d 13,499.92 GRAND TOTALS \$50,136.08 \$4,275.72 \$45,860.36 Notes: (A) Solder pots, cleaning and rinzing pots, tweezers, bench and stool; cost for 6 stations = \$1,008.70 (B) 4 (.02 & .01) cap's x 40 = 160 pcs/hr x 4,000 = 640,000 8 (two .01) x 40 = 320 x 4,000 = 1,280,000 7 (one .01) x 40 = 280 x 4,000 = 1,120,000 3,040,000 annual prod. (C) 2.112 (men/hr to make 40 mod/hr) x 4,000 hrs = 8,448.00 dir. lab. hrs. 2.288 (1. Material		xx	
a. Ind. Lab. = 30% of Dir. 36,636.16 = 10,990.85 \$3,297.26 7,693.59 b. Mach., Equip. & Tool 201.80 163.96 37.84 c. Occupancy = Proc. Space (D) 180 x Ratio 5 = 900 sq. ft. Rent 900 x.3 = 270.00 27.00 243.00 Heat 900 x.1 = 90.00 67.50 22.50 Subtotal - a, b, and c 12,272.65 d. Miscellaneous = 10% x Subtotal 12,272.65 = 1,227.27 1,227.27 Total - a, b, c, and d 13,499.92 GRAND TOTALS \$50,136.08 \$4,275.72 \$45,860.36 Notes: (A) Solder pots, cleaning and rinsing pots, tweezers, bench and stool; cost for 6 stations = \$1,008.70 (B) 4 (.02 & .01) cap's x 40 = 160 pcs/hr x 4,000 = 640,000 8 (two .01) " x 40 = 320 " x 4,000 = 1,280,000 7 (one .01) " x 40 = 280 " x 4,000 = 1,120,000 7 (one .01) " x 40 = 280 " x 4,000 = 1,120,000 (C) 2.112 (men/hr to make 40 mod/hr) x 4,000 hrs = 8,448.00 dir. lab. hrs. 2.288 (2. Direct Labor = (C) 22, 897 x Rate 1.6 =	\$36,636.16	xx	\$36,636.16
c. Occupancy = Proc. Space(D) 180 x Ratio 5 = 900 sq. ft. Rent 900 x . 8 = 720.00 720.00 Light 900 x . 3 = 270.00 27.00 243.00 Heat 900 x . 1 = 90.00 67.50 22.50 Subtotal - a, b, and c 12,272.65 d. Miscellaneous = 10% x Subtotal 12,272.65 = 1,227.27 1,227.27 Total - a, b, c, and d 13,499.92 GRAND TOTALS \$50,136.08 \$4,275.72 \$45,860.36 Notes: (A) Solder pots, cleaning and ringing pots, tweezers, bench and stool; cost for 6 stations = \$1,008.70 (B) 4 (.02 & .01) cap's x 40 = 160 pcs/hr x 4,000 = 640,000 8 (two .01) " x 40 = 320 " x 4,000 = 1,280,000 7 (one .01) " x 40 = 280 " x 4,000 = 1,120,000 3,040,000 annual prod. (C) 2.112 (men/hr to make 40 mod/hr) x 4,000 hrs = 8,448.00 dir. lab. hrs. 2.288 (") x 4,000 = 9,152.00 " 1.3244(") x 4,000 = 5,297.60 " (D) Based on 30 sq. ft. x 6 stations = 130 sq. ft. Cost per piece = \$50,136.08 = .0165	——————————————————————————————————————	10, 990. 85	\$3,297.26	7, 693. 59
Proc. Space (D) 180 x Ratio 5 = 900 sq. ft. Rent 900 x .8	b. Mach., Equip. & Tool	201.80	163.96	37.84
Subtotal - a, b, and c 12,272.65 d. Miscellaneous = 10% x Subtotal 12,272.65 = 1,227.27 Total - a, b, c, and d 13,499.92 GRAND TOTALS \$50,136.08 \$4,275.72 \$45,860.36 Notes: (A) Solder pots, cleaning and rinsing pots, tweezers, bench and stool; cost for 6 stations = \$1,008.70 (B) 4 (.02 & .01) cap's x 40 = 160 pcs/hr x 4,000 = 640,000 8 (two .01) " x 40 = 320 " x 4,000 = 1,280,000 7 (one .01) " x 40 = 280 " x 4,000 = 1,120,000 7 (one .01) " x 40 = 280 " x 4,000 = 1,120,000 (C) 2.112 (men/hr to make 40 mod/hr) x 4,000 hrs = 8,448.00 dir. lab. hrs. 2.288 (") x 4,000 = 9,152.00 " 1.3244 (") x 4,000 = 5,297.60 " (D) Based on 30 sq. ft. x 6 stations = 130 sq. ft. Cost per piece = \$50,136.08 = .0165	Proc. Space (D) 180 x Ratio $5 = 900 \text{ sq. ft.}$ Rent $900 \times .8 = 1000 \times .3 = 1000 \times .3$	270.00	27.00	243, 00 22, 50
10% x Subtotal 12,272.65 = 1,227.27 1,227.27 Total - a, b, c, and d 13,499.92 GRAND TOTALS \$50,136.08 \$4,275.72 \$45,860.36 Notes: (A) Solder pots, cleaning and rinsing pots, tweezers, bench and stool; cost for 6 stations = \$1,008.70 (B) 4 (.02 & .01) cap's x 40 = 160 pcs/hr x 4,000 = 640,000 8 (two .01) " x 40 = 320 " x 4,000 = 1,280,090 7 (one .01) " x 40 = 280 " x 4,000 = 1,120,000 3,040,000 annual prod. (C) 2.112 (men/hr to make 40 mod/hr) x 4,000 hrs = 8,448.00 dir. lab. hrs. 2.288 (Subtotal - a, b, and c	12,272.65		
GRAND TOTALS \$50,136.08 \$4,275.72 \$45,860.36 Notes: (A) Solder pots, cleaning and ringing pots, tweezers, bench and stool; cost for 6 stations = \$1,008.70 (B) 4 (.02 & .01) cap's x 40 = 160 pcs/hr x 4,000 = 640,000 8 (two .01) " x 40 = 320 " x 4,000 = 1,280,090 7 (one .01) " x 40 = 280 " x 4,000 = 1,120,000 3,040,000 annual prod. (C) 2.112 (men/hr to make 40 mod/hr) x 4,000 hrs = 8,448.00 dir. lab. hrs. 2.288 (") x 4,000 = 9,152.00 " 1.3244 (") x 4,000 = 5,297.60 " (D) Based on 30 sq. ft. x 6 stations = 130 sq. ft. Cost per piece = \$50,136.08 = .0165		1,227.27		1,227.27
Notes: (A) Solder pots, cleaning and rinsing pots, tweezers, bench and stool; cost for 6 stations = \$1,008.70 (B) 4 (.02 & .01) cap's x 40 = 160 pcs/hr x 4,000 = 640,000 8 (two .01) " x 40 = 320 " x 4,000 = 1,280,000 7 (one .01) " x 40 = 280 " x 4,000 = 1,120,000 760 3,040,000 annual prod. (C) 2.112 (men/hr to make 40 mod/hr) x 4,000 hrs = 8,448.00 dir. lab. hrs. 2.288 (") x 4,000 = 9,152.00 " 1.3244 (") x 4,000 = 5,297.60 " (D) Based on 30 sq. ft. x 6 stations = 130 sq. ft. Cost per piece = \$50,136.08 = .0165	Total - a, b, c, and d	13,499.92		=======================================
(A) Solder pots, cleaning and rinsing pots, tweezers, bench and stool; cost for 6 stations = \$1,008.70 (B) 4 (.02 & .01) cap's x 40 = 160 pcs/hr x 4,000 = 640,000 8 (two .01) " x 40 = 320 " x 4,000 = 1,280,090 7 (one .01) " x 40 = 280 " x 4,000 = 1,120,000 760 3,040,000 annual prod. (C) 2.112 (men/hr to make 40 mod/hr) x 4,000 hrs = 8,448.00 dir. lab. hrs. 2.288 (") x 4,000 = 9,152.00 " 1.3244 (") x 4,000 = 5,297.60 " (D) Based on 30 sq. ft. x 6 stations = 130 sq. ft. Cost per piece = \$50,136.08 = .0165 96	GRAND TOTALS	\$50, 135.08	\$4,275.72	\$45,860.36
Cost per piece = \$50, 136.08 0165 96	(A) Solder pots, cleaning and rinsing p stool; cost for 6 stations = \$1,008. (B) 4 (.02 & .01) cap's x 40 = 160 pcs/ 8 (two .01) " x 40 = 320 " 7 (one .01) " x 40 = 280 " (C) 2.112 (men/hr to make 40 mod/hr) 2.288 (") 1.3244 (")	70 hr x 4,000 = x 4,000 = 1 x 4,000 = 1 3 x 4,000 hrs = x 4,000 = x 4,000 =	640,000 ,280,000 ,120,000 ,040,000 and 8,448.00 dir. 9,152.00 5,297.60	lab. hrs.
	Cost per piece = \$50,136.080165	•		96

Processes Assemble Capacitor Loads	Hand	No. HC-	6a
Equipment (A)			
Based on 2 shifts, 4,000 hrs., hrly. prod. (B)	880 and annu	al prod. (B)	3,520,000
		Annual Cos	t
	Total	Fixed	Variable
1. Material		хх	
2. Direct Labor = hrs. (C) 39,529.6 x Rate 1.6	\$63, 247. 36	xx	\$63,247.36
3. Manufacturing Overhead			
a. Ind. Lab. = 30% of Dir. 63,247.36 =	18, 974. 21	\$5,692.26	13,281.95
b. Mach., Equip. & Tool	95.00	77.19	17.81
c. Occupancy =			
Proc. Space (D) 300 x Ratio $5 = 1,500 \text{ sq.}$			
Rent 1500 x . 8 = Light 1500 x . 3 =	1,200.00 450.00	1,200.00 45.00	405.00
$\begin{array}{ccc} \text{Light} & 1500 \text{ x. 3} & = \\ \text{Heat} & 1500 \text{ x. i} & = \end{array}$	150.00	112.50	37.50
Subtotal - a,b, and c	\$ 20,869.21		
d. Miscellaneous =			
10% x Subtotal 20, 869. 21 =	2,086.92	·	2,086.92
Total - a, b, c, and d	22, 956. 13		
GRAND TOTALS	\$86,203.49	\$7,126.95	\$79,076,54
Notes:			
(A) Hand soldering iron, bench, stool;			74.93
(B) 10 ops one side x 40 ops/hr = 400 12 ops two sides x 40 '' = 480			
880	x 4,000 Hrs		pcs annual prod
(C) 3. 124 (men/hr to make 40 mod/hr)	\ ~ 4 000 - 11		-
6. 7584 ("			
· · · · · · · · · · · · · · · · · · ·		9,529.60	п
(D) Based on 30 sq. ft. x 10 stations =	300 sq. ft.		
Cost per piece = $\frac{$86,203.49}{3,520,000}$ = .02	45		

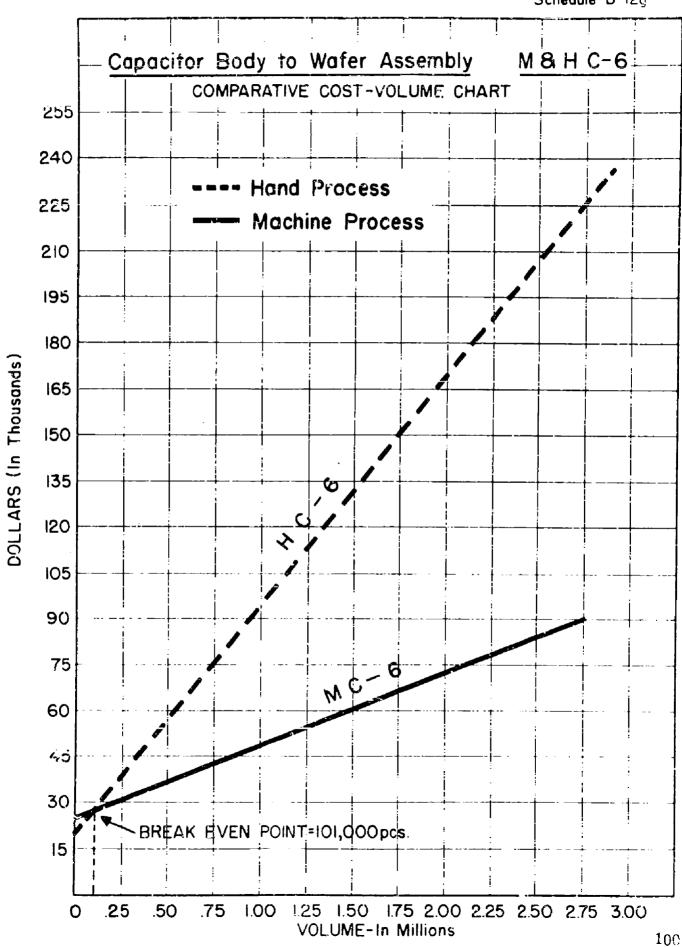
PROJECT TINKERTOY Manufacturing Cost	Data		
Processes Subassemble Capacitors	Hand	No. HC-	6Ъ
Equipment (A)			
Based on 2 shifts, 4.000 hrs., hourly prod. 20	00 and annual	prod. 800,0	00 (B)
		Annual Cos	ts
	Total	Fixed	Variable
1. Material		xx	
2. Direct Labor = Hrs. 7,792 (C) x Rate 1.6 =	\$12,467.20	хх	\$12,467.20
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 12,467.20 =	3,740.16	\$1,122.05	2,618.11
b. Mach., Equip., & Tool	75.60	61.43	14.17
c. Occupancy = Proc. Space 60 (D) x Ratio 5 = 300 sq.ft.			
Rent 300 x . 0 +	240.00	240.00	
$Light = 300 \times .3 =$	90.00	9.00	81,00
Heat $300 \times .1$	30.00	22.50	7,50
Subtotal - a, b, and c	\$ 4,175.76		
d. Miscellaneous *			
$10\% \times \text{Subtotal} \ \underline{4,175.76} =$	417, 58		417.58
Total ~ a, b, c, and d	4,593.34		
GRAND TOTALS	\$17,060.54	\$1,454.98	\$15,605.56

Notes:

- (A) Solder pot, cleaning & rinsing pot, overhead exhaust, bench, stool (cost for 2 stations = \$378)
- (B) $5 \times 40 = 200$ hrly. prod., $200 \times 4,000 = 800,000$ annual prod.
- (C) $1.9480 \times 4,000 = 7,792 \text{ dir. lab. hrs.}$
- (D) 2 stations x 30 sq. ft. = 60 sq. ft.

Cost per piece = \$17,060.54 = .0213800,000 pcs

PROJECT TINKERTOY Manufacturing Cost	Data		edule D-12t
Processes Apply Protective Coating	Hand	No. HC-6	, oc
Equipment (A)			
Based on 2 shifts, 4,000 hrs., hrly. prod. (B)	— 720 and annual	prod. (B) 2	.880.000
		nnual Cost	
	Total	Fixed	- Variable
	1 Otal	Tixed	Vallable
1. Material		хх	
2. Dir. Lab. = hrs.(C) 37, 945.6 x Rate 1.6 =	\$60,712.96	xx	\$60,712.96
 Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 60,712.96 = 	18, 213. 89	\$5,464 .17	12,749.72
b. Mach., Equip. & Tool	66.80	54. 28	12.52
c. Occupancy = Proc. Space (D) 300 x Ratio 5 = 1,500 sq. fr Rent 1,500 x .8 = Light 1,500 x .3 = Heat 1,500 x .1 =	1,200.00 450.00 150.00	1,200.00 45.00 112.50	405.00 37.50
Subtotal - a, b, and c	20,080.69		
d. Miscellaneous =			
$10\% \times \text{Subtotal} = 20,080.69 =$	2,008.07		2,008.07
Total - a, b, c, and d	22,088.76		: ====================================
GRAND TOTALS	\$82,801.72	\$6,875 .95	\$75,925.77
Notes: (A) Bench, stool, artists brushes, hysol containers; cost for 10 sta. = \$334.40 (B) 8 ops on one side x 40 = 320 pcs/hr x 4,000 = 1,280,000 10 ops on two sides x 40 = 400 pcs/hr x 4,000 = 1,600,000 720 pcs/hr			



Processes Capacitor Wafer Assembly Notch Solder Filling Mach. No. MC-7

Equipment 2-Notch Timers (A)

Based on 2 shifts, 3,375 hrs., hourly prod. 816 and annual prod. 2,754,000

		Annual Co	ets
	Total	Fixed	<u>Variable</u>
1. Material		xx	
2. Direct Labor = Hrs. 4,000 x Rate 2.40 (B) =	\$9,600	хx	\$9,600
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 9,600 =	2,880	\$ 864	2,016
b. Mach., Equip. & Tool	4,767	2,435	2, 332
c. Occupancy = Proc. Space 60 x Ratio 6 = 360 sq. ft. Rent 360 x 1.00 =	360	360	
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	108 36	11 27	97 9
Subtotal - a, b, and c	8,151	3, 697	4,454
d. Miscellaneous = 10% x Subtotal 8,151 =	815	370	445
Total - a, b, c, and d	8,966	4,067	4,899
GRAND TOTALS	\$18,566	\$4,067	\$14,499

Notes: (A) 2 Notch Tinners @ \$5,700 = \$11,500.

(B) 2 Unskilled @ \$1.20 = \$2.40

Cost per piece = $\frac{$18,566}{2,754,000} = .00674$

Process Canacitor Wafer Assembly Notch Solder Filling Hand No. HC-7

Equipment Benches, stools, soldering irons, and fixtures (A)

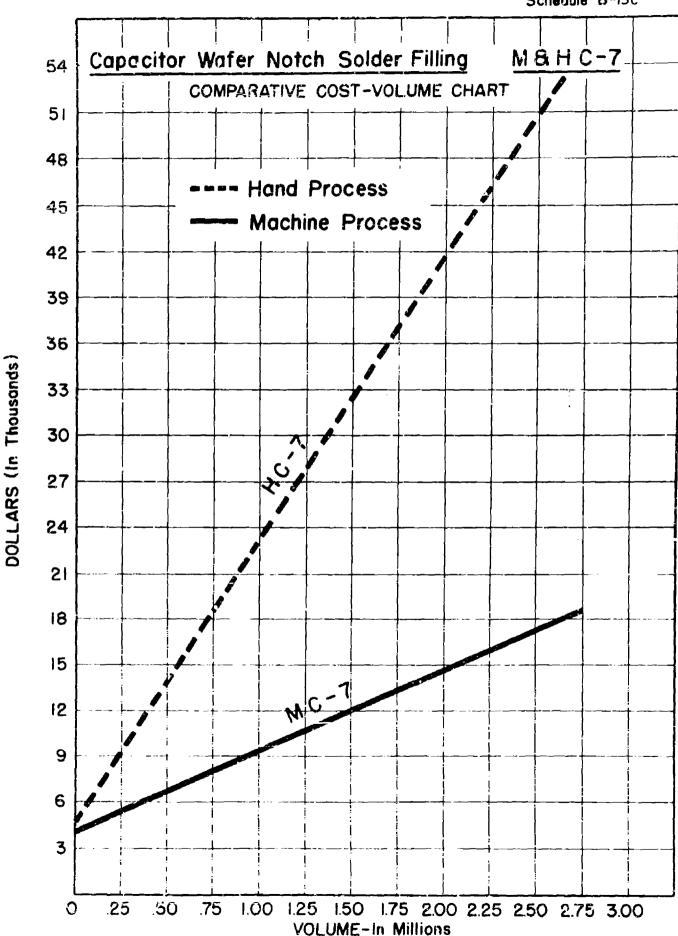
Based on 2 shifts, 4000 hrs., hourly prod. 720 and annual prod. 2,880,000 (B)

	Annual Costs		
	Total	Fixed	Variable
1. Material		xx	
2. Direct Labor = Hrs. 25, 344.00 (C) x Rate 1.6 =	\$40,550.40	xx	\$40,550.40
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 40,550.40 =	12, 165. 12	\$3,649.54	8, 515.858
b. Mach., Equip. & Tool	63.00	51. 19	11.81
c. Occupancy = Proc. Space 180(D) x Ratio 5 = 900 sq. ft.			
Rent $900 \times .8$ = Light $900 \times .3$ =	720. 00 270. 00	720. 00 27. 00	243.00
Heat 900 x .1 =	90.00	67. 50	22,50
Subtotal - a, b, and c	13, 308. 12		
d. Miscellaneous = 10% x Subtotal 13, 308. 12 =	1, 330.81	-	1, 330.81
Total - a, b, c, and d	14, 638. 93		
GRAND TOTALS	\$55, 189. 33	\$4, 515. 23	\$50,674.10

Notes:

Cost per piece = \$55,189.33 = .019? 2,880,000

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Processes Capacitor Wafer Assembly Inspection Mach. No. MC-8

Equipment 2 Capacitor Assembly Testers (A)

Based on 2 shifts, 2,822 hrs., hourly prod. 976 and annual prod. 2,754,000

			·	
			Annual Cos	ts
		Total	Fixed	Variable
1. Material			xx	
2. Direct Labor = Hrs. 3,440 x Rate 4.60) (B) =	\$ 16, 512	ж	<u>\$16,512</u>
 Manufacturing Overhead a. Ind. Lab. = 30% of Dir 	. 16,512 =	4,954	\$1,48 6	3,468
b. Mach., Equip. & Tool	l	9,627	5,081	4,546
c. Occupancy = Proc. Space 92 x Rati Rent 552 x 1.00		552	552	
Light 552 x .30 Heat 552 x .10	=	166 55	17 42	149
Subto	tal - a, b, and c	\$15, 354	\$7,178	\$ 8,176
d. Miscellaneous =				
10% x Subtotal 15, 35	<u> </u>	1,535	718	817
Total	- a, b, c, and d	16,889	7,896	8,993
GRAN	ND TOTALS	\$33,401	\$7,896	\$25,505

Notes: (A) 2 Testers @ \$12,000 = \$24,000

(B) 2 Highly Skilled @ \$2.40 = \$4.80

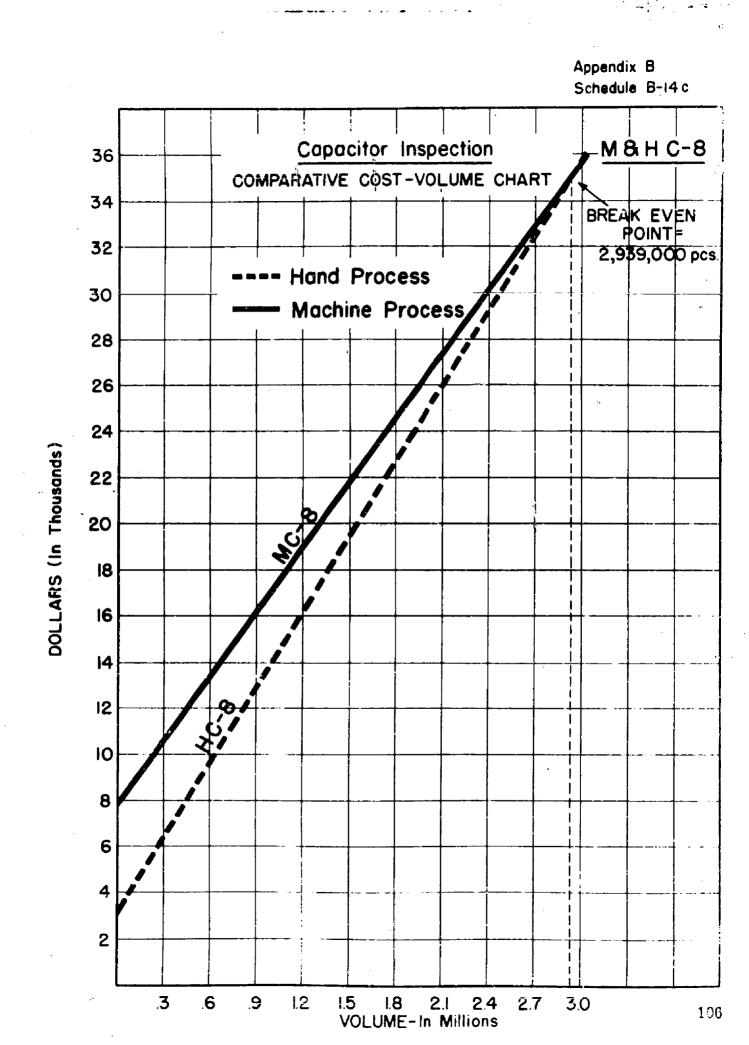
Cost per piece = $\frac{$33,401}{2,754,000}$ = .0121

FROJECT TINKERTOY Manufacturing Cost	Data		
Processes Capacitor Wafer Assembly Inspect	ion Hand	No. HC-	8
Equipment Beaches, stools & electrical tester	rs (A)		
Based on 2 shifts, 4,000 hrs., hourly prod. 1,	360 ops. and	annual prod	wafers . 2,880.000
		Annual Cos	<u>t</u>
	Total	Fixed	Variable
l. Material	·	xx	
2. Direct Labor = Hrs. 15,558.4 (B) x Rate 1.6 =	\$24,893.44	хх	\$24, 893. 44
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 24, 893, 44 =	7,668.03	\$2,300.41	5, 367, 62
b. Mach., Equip. & Tool	432,00	351.00	81,00
C. Occupancy = Proc. Space 120 (C) x Ratio 5 = 600 sq. ft Heat $600 \times .8 = $ Light $600 \times .3 = $ Heat $600 \times .1 = $	480.00 180.00 60.00	480.00 18.00 45.00	162, 00 15, 00
Subtotal a, b, and c	\$ 8,820,03		
d Miscellaneous = 10% x Subtotal 8,820.03 = Total - a, b, c, and d	882.00 9,702.03		882.00
GRAND TOTALS	\$34,595.47	\$3, 194, 41	\$31,401.06

Notes.

- (A) Cost for 4 stations = \$2,160
 (B) 3.88960 x 4,000 = 15.558,40 Dir. Lab. Hrs.
- (C) 4 stations x 30 sq. ft. 120

Cost per waser = \$34,595.47 = .0120 2,880,000



Processes Tube Socket Wafer Pattern Tinning	Mach.	No. MTS-	1
Equipment (A)	_		
Based on 2 shifts, 4,000 hrs., hourly prod. 1,	296 and annua	l prod. <u>1,79</u>	4,000 (B) ⁸
	<u>A</u>	nnual Costs	
	Total	Fixed	Variable
1. Material		xx	
2. Direct Labor =			1.
Hrs. $4,000 \times \text{Rate } 4.80 =$	\$19,200.00	ж	\$19,200.00
3. Manufacturing Overhead			
a. Ind. ab. = 30% of Dir. 19,200 =	5, 760. 00	\$1,728.00	4,032.00
b. Mach., Equip. & Tool	3,732.00	3,420.00	312.00
c. Occupancy =			
Proc. Space $66 \times \text{Ratio } 6 = 396 \text{ sq. ft.}$			
Rent 396 x 1.00 =	396.00	396.00	
$Light 396 \times 30 =$	119.00	12.00	107.00
$Heat = 396 \times .10 =$	40.00	30.00	10.00
Subtotal - a, b, and c	\$10,047.00	\$5,586.00	\$ 4,461.00
d. Miscellaneous =			
10% x Subtotal 10,047.00=	1,005.00	559.00	446.00
Total - a, b, c, and d	11,052.00	6,145.00	4,907.00
GRAND TOTALS	\$30,252.00	\$6,145.00	\$24, 107. 00

Notes: (A) Operation accomplished on pattern tinner used also for capacitor wafers (see C-1).

(B) Annual production of wafers as follows:

Capacitor wafers = 3,390,000
Tube socket wafers = 1,794,000
5,184,000

An individual comparative cost-volume chart has not been prepared for MTS-1 and HTS-1 because of the combination of capacitor and tube socket wafer processing in the machine process manufacture. A combined chart has been prepared as Schedule 8c for MC-1 and MTS-1 vs. HC-1 and HTS-1.

PROJECT TINKERTOY -- Manufacturing Cost Data Process Tube Socket Wafer Pattern Tinning Hand No. HTS-1 Equipment (A) Based on 2 shifts, 4,000 hrs., hourly prod. 720 and annual prod. 1,440,000 (B) Annual Costs Total Fixed Variable 1. Material ХX 2. Direct Labor = Hrs. 8,481.60 (C) x Rate 1.6 =**\$**13, 570. 56 **\$**13,570.56 3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 13,570.56 = 4,071.17 \$1,221.35 2,849,82 75.00 60.94 14.06 b. Mach., Equip. & Tool c. Occupancy = Proc. Space 60 (D) x Ratio 5x 300 sq. ft. Rent 300 x 240.00 240.00 90.00 9.00 Light 300 x 81.00 Heat 300 x 30.00 22.50 7.50 4, 506, 17 Subtotal - a, b, and c d. Miscellaneous : 10% x Subtotal 4, 506, 17 450.62 450,62 Total - a, b, c, and d 4, 956. 79

Notes:

(A) Same as HC-1 but 2 stations, cost = \$375.

GRAND TOTALS

(B) 9 ops. $\times 40^{-360} \times 4000 = 1,440,000$ annual production

\$18,527.35

- (C) 2.12040 x 4000 = 8,481.60 Direct Labor Hrs.
- (D) 2 stations \times 30 sq. ft. = 60

Gost per piece = \$18,527.35 = .0129 1,440,000 \$1,553.79 \$16,973.56

Processes Tube Socket Parts to Wafer Assembly Mach. No. MTS-2

Equipment 3-Tube Socket Assemblers (A)

Based on 2 shifts, 3, 115 hrs., hourly prod. 468 and annual prod. 1,458,000

	Annual Cost		
	Total	Fixed	Variable
l. Material		xx	
2. Direct Labor = Hrs. 3,720 x Rate 7.20 (B) =	\$26,784	xx	\$26,784
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 26,784 =	8,035	\$ 2,411	5,624
b. Mach., Equip. & Tool	38,475	20,325	18, 150
c. Occupancy = Proc. Space 180 x Ratio 6 = 1,080 sq.ft. Rent	1,080 324 108	1,080 32 81	292 27
Subtotal - a, b, and c	\$48,022	\$23,929	\$24,093
d. Miscellaneous = 10% x Subtotal 48,022 =	4,802	2,393	2,409
Total - a, b, c, and d	52,824	26,322	26,502
GRAND TOTALS	\$79,608	\$26,322	\$53,286

Notes:

- (A) 3-Tube Socket Assemblers @ \$32,000 = \$96,000
- (B) 2-Skilled @ \$2.00 = \$4.00 2-Semi-skilled @ \$1.60 = 3.20 \$7.20

Cost per piece = $\frac{$79,608}{1,458,000}$ = .0546

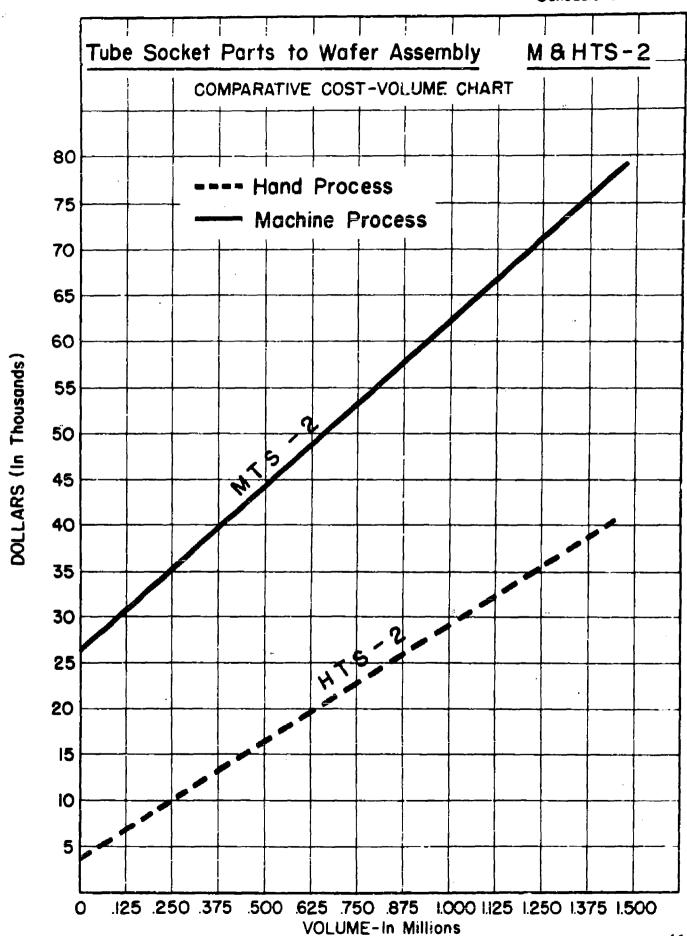
Processes Tube Socket Parts-to-Wafer Assembly Hand No. HTS-2 Equipment Benches, stools, eyeletting mach, and spec. fixtures (A) Based on 2 shifts, 4,000 hrs., hourly prod. 360 and annual prod. 1,440,000 (B) Annual Costs Total Fixed Variable l. Material XX 2. Direct Labor = Hrs. 18, 374. 40 (C) \times Rate 1.6 = \$29, 399. 04 **\$**29, 399. 04 ХX 3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 29, 399.04 = 8,819.71 \$2,645.91 6, 173.80 b. Mach., Equip. & Tool 270.60 219.86 50.74 c. Occupancy = Proc. Space $150(D) \times Ratio 5 = 750 sq. ft$. 750 x .8 (00.00 600.00 Rent 225.00 22.50 Light 750 202.50 Heat 750 75.00 56, 25 18.75 Subtotal - a, b, and c 9,990.31 d. Miscellaneous = $10\% \times Subtotal 9,990,31 =$ 999.03 999.03 Total - a, b, c, and d 10, 989. 34 GRAND TOTALS \$40,388.38 **\$3,544.52 \$36,843.86**

Notes:

- (A) Equipment for 5 stations = \$1,353.
- (B) 9 ops x 40 = 360 per hr. x 4,000 = 1,440,000 annual prod.
- (C) $4.59360 \times 4,000 = 18,374,40 \text{ Dir. Lab. Hrs.}$
- (D) 5 stations \times 30 = 150

Cost per piece = \$40,388.38 = .028 1,440,000

111



Tube Socket Notch Solder Filling Mach. No. MTS-3 Equipment | 1 Notch Tinner (A) Based on 2 shifts, 3,574 hrs., hourly prod. 408 and annual prod. 1,458,000 Annual Cost Total Fixed Variable l. Material $\mathbf{x}\mathbf{x}$ 2. Direct Labor . \$4,800 Hrs. 4,000 x Rate 1.20 . XX \$4,800 3. Manufacturing Overhead a. Ind. Lab. . 30% of Dir. 4,800 1,440 \$ 432 1,008 b. Mach., Equip. & Tool 2,380 1,218 1, 162 c. Occupancy . Proc. Space 25 x Ratio 5 - 150 sq.ft. 150 x 1,00 150 150 Rent 40 150 x .30 Light 45 Heat 150 x .10 12 3 15 \$4,030 \$1,817 Subtotal - a, b, and c \$2,213 d. Miscellaneous z 10% x Subtotal 4,030 = 221 182 403 Total - a, b, c, and d 4, 433 1,999 2,434 GRAND TOTALS **\$**9,233 \$1,999 **\$**7,234 Notes: (A) ! Notch Tinner @ \$5,750 (B) 1 Unskilled @ \$1.20

\$9,233

1,458,000

.0063

PROJECT TINKERTOY -- Manufacturing Cost Data

Cost per piece .

Processes Tube Socket Notch-to-Connector Soldering Hand No. HTS-3

Equipment Benches, stools, solder pots, tweezers, overhead hood (A)

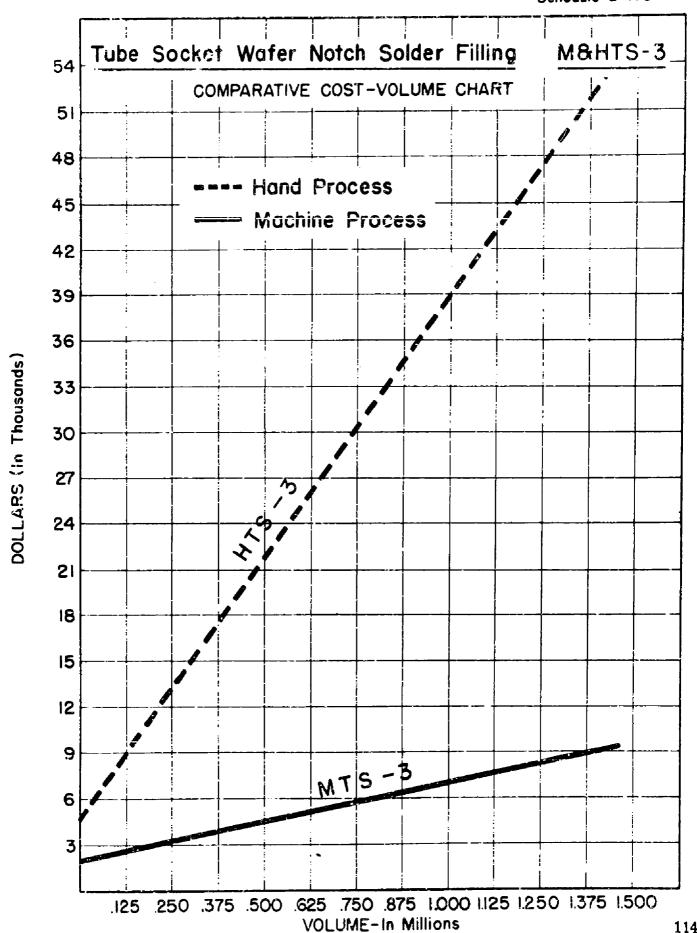
Based on 2 shifts, 4,000 hrs.. hourly prod. 360 and annual prod. 1,440,000 (B)

	Annual Cost		<u>t</u>
	Total	Fixed	Variable
1. Material		××	
2. Direct Labor =			
Hrs. $24,710,40$ (C) x Rate $1.6 =$	\$39,536.64	xx	\$39,536.64
3. Manufacturing Overhead			
a. Ind. Lab. = 30% of Dir. 39,536. 3	11,860.99	\$3,558.30	8, 302, 69
b. Mach,, Equip. & Tool	279. 20	226.85	52, 35
c. Occupancy =			
Proc. Space 180 x Ratio 5 = 900 sq.ft.			
Rent 900 x . 8	720.00	720.00	~= +-
Light 900 x . 3 =	270.00	27.00	243.00
Heat 900 x . 1	90.00	67.50	22.50
Subtotal - a, b, and c	\$13,220.19		
d. Miscellaneous =			
10% x Subtotal 13, 220, 19 =	1,322.02		1,322.02
GRAND TOTALS	\$54,078.85	\$4,599.65	\$49,479.20

Notes:

- (A) Equipment for 6 stations = \$1,396
- (B) $9 \text{ ops} \times 40 = 360 \text{ per hr.} \times 4,600$
- (C) $6.17760 \times 4,000 = 24,710.40 \text{ Dir. Lab. Hrs.}$
- (D) 6 stations x 30 sq. ft. = 180

Cost per piece = \$54,078.85 = .03751,440,000



114

PROJECT TINKERTOY Manufacturing Cost	Data		,
Processes Elect. Inspection of Tube Sockets	Hand	No. HTS	-4
Equipment Benches, stools and meters (A)			
Based on 2 shifts, 4,000 hrs., hourly prod. 36	0 and annual	prod. 1,440	,000 (B)
		Annual Cos	<u>t</u>
	Total	Fixed	Variable
1. Material		xx	
2. Direct Labor = Ers. 7,545.60 (C) x Rate 1.6 =	\$12,072.96	жж	\$12,072.96
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 12,072.96	3,621.89	\$1,086.57	2,535.32
b. Mach., Equip. & Tool	71.60	58, 18	13, 42
c. Occupancy = Proc. Space 60 (D) x Ratio 5 = 300 sq.ft.			
Rent 300 x 8	240.00	240.00	
$Light = 300 \times .3 =$	90.00	9.00	81.00
Heat 360 x . 1 =	30.00	22.50	7,50
Subtotal - 2, b, and c	\$ 4,053.49		

Notes:

d. Miscellaneous =

- (A) Equipment for 2 stations @ \$358.
- (B) 9 opers $\times 40 = 360 \times 4,000$

10% x Subtotal 4,053.49 =

(C) $1.88640 \times 4,000 = 7,545.60 \text{ Dir. Lab. Hrs.}$

Total - a, b, c, and &

GRAND TOTALS

(D) 2 stations \times 30 = 60 sq. ft.

Cost per piece = \$16,531.80 = .0115 1,440,000

- · · · · .

This operation is not performed in present machine process manufacture, and therefore the cost is not charged against the projected hand process.

405.35

\$16,531.80 \$1,416.25 \$15,115.55

4,458.84

405.35

Equipment 5 Module Assemblers (A) Based on 2 shifts, 3,471 hrs., hourly prod. 420	O and annua	l prod. <u>1,45</u>	8,000
Based on 2 shifts, 3,471 hrs., hourly prod. 420	o and annua	l prod. <u>1,45</u>	8,000
		Annual Co	st
	Total	Fixed	Variable
1. Material		хx	
2. Direct Labor = Hrs. 4,000 x Rate 16.00 (B) = \$	64,000	жж	\$ 64,000
3. Manufacturing Overhead a. Indirect Labor = 30% of Dir. 64,000 =	19, 197	\$ 5,757	13,440
b. Mach., Equip. & Tool	62,924	33,342	29,582
c. Occupancy = Proc. Space 590 x Ratio 6 = 3,540 sq. ft. Rent 3540 x 1.00 = Light 3540 x .30 = Heat 3540 x .10 =	3,540 1,061 356	3,540 104 260	957 96
Subtotal - a,b, and c \$	87,078	\$43,003	\$ 44,075
d. Miscellaneous = 10% x Subtotal 87,078 =	8,708	4,300	4,408
Total - a,b,c, and d	95, 786	47,303	48,483
GRAND TOTALS \$	159, 786	\$47,303	\$112,483

Notes:

- (A) 5 Module Assemblers @ \$31,500 = \$157,500
- (B) 10 Semi-skilled @ 1.60 = \$16.00

Cost per piece = \$159,786 = .1096

Processes Module Assembly	Hand	No. HM-	<u>l</u>
Equipment Benches, stools and assembly fixt	ures		
Based on 2 shifts, 4,000 hrs., hourly prod. 4	00 and annual	prod. 1,600,	,000 (B)
		Annual Cost	
	1 otal	Fixed	Variable
l. Material		ж	
2. Direct Labor = Hrs. 67,760.0 x Rate 1.6 =	\$ <u>108,416.00</u>	хх	\$108,416.00
3. Manufacturing Overhead a. Ind. Lab 30% of Dir. 108,416.00 =	32,524.80	\$ 9,757.44	22,767.36
b. Mach., Equip. & Tool	5,273.10	3,295.69	1,977.41
c. Occupancy = Proc. Space 510 (D) x Ratio 5 = 2,550 sc Rent 2550 x . 8 = Light 2550 x . 3 = Heat 2550 x . 1 =	2,040.00 765.00 255.00	2,040.00 76.50 191.25	688.50
Subtotal - a,b, and c			
d. Miscellaneous = 10% x Subtotal 40,857.90 =	4,085.79		4,085.79

Notes:

- (A) Cost for 17 stations = \$17,577
- (B) 10 opers \times 40 * 400 \times 4,000 = 1,600,000 annual prod.

Total - a, b, c, and d

GRAND TOTALS

44, 943, 69

\$153,359.69

- (C) $16.940 \times 4,000 = 67,760$
- (D) 17 stations x 30 sq. ft. = 510

Cost per piece $\frac{$153,359.69}{1,600,000} = .0958$

\$15,360.88 \$137,998.81

Processes Inspect. & Resoldering of Module Assembly Hand No. HM-la

Equipment Benches, stools & soldering irons (A)

Based on 2 shifts, 4,000 hrs., hourly prod. 400 and annual prod. 1,600,000

		Annual Cos	t -
	Total	Fixed	Variable
1. Material		xx	
2. Direct Labor = Hrs. 27,984.00 (B) x Rate 1.6 =	\$44,744.40	хx	\$44,744.40
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 44,744.40 =	13,432,32	\$4,029.70	9,402.62
b. Mach., Equip. & Tool	74.60	60.61	13.99
c. Occupancy = Proc. Space 210 (C) x Ratio 5 = 1,050 sq Rent $\frac{1050 \times .8}{1050 \times .3}$ = Heat $\frac{1050 \times .1}{1050 \times .1}$ = Subtotal - a,b, and c	340,00 315,00 105,00		283.50 26.25
d. Miscellaneous = 10% x Subtotal 14,766.92 = Total - a,b,c, and d	1,476.69 16,243.61		1,476.69
GRAND TOTALS	\$60, 988. 01	\$5,040.56	\$55,947.45

Notes:

- (A) Cost of equipment for 7 stations = \$373
- (B) $6.996 \times 4,000 = 27,984$
- (C) 7 stations x 30 sq. ft. = 210 sq. ft.

Cost per piece = $\frac{$60,988.01}{1,600,000}$ = .0381

This is essentially a salvaging operation which is not being performed in the present machine process manufacture and therefore is not being charged against the projected hand process manufacture.

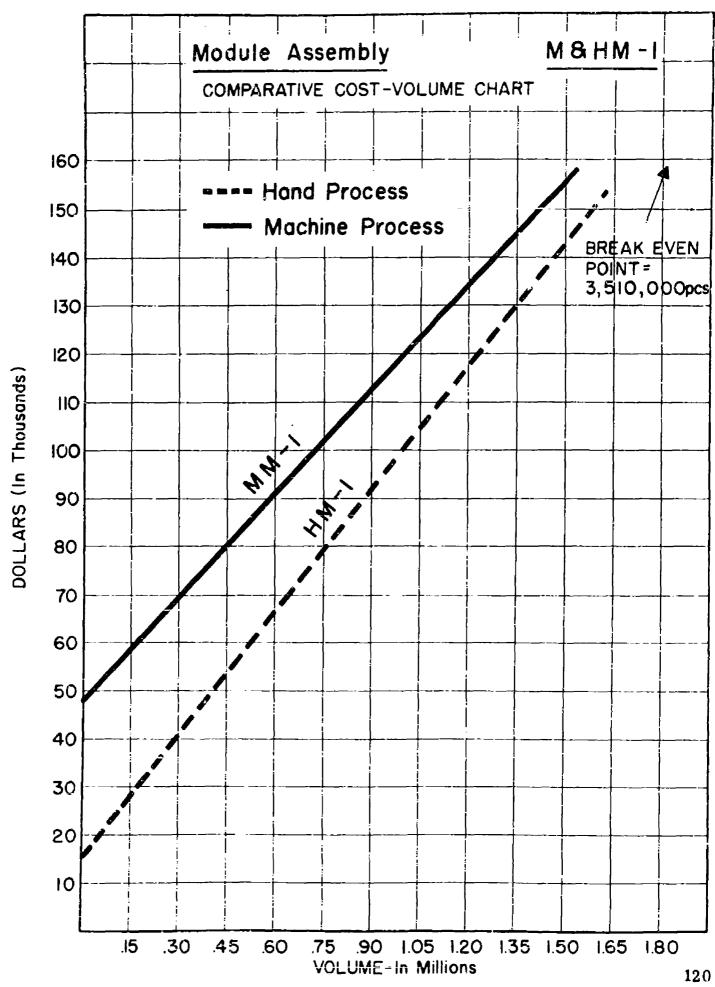
PROJECT TINKERTOY Manufacturing Cost Data			
Processes Straighten Module Wire-ends	Hand	No. HM-	1b
Equipment Benches, stools & straightening jig	(s (A)		
Based on 2 shifts, 4,000 hrs., hourly prod. 400 and annual prod. 1,600,000 (B)			
		Annual Cos	<u>t</u>
	Total	Fixed	<u>Variable</u>
1. Material		xx	
2. Direct Labor • Hrs. 14,080.00 (C) x Rate 1.6 =	\$22,528.00	хх	\$22,528.00
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 22,528.00 =	6,758.40	\$2,027.52	4,730.88
b. Mach., Equip. & Tool	40.00	32,50	7.50
c. Occupancy = Proc. Space 120 (D) x Ratio 5 = 600 sq. ft Rent 600 x . 8 =	t. 480.00	480.00	
$Light = \frac{600 \times .3}{2} =$	180.00	18.00	162.00
Heat 600 x . 1 =	60.00	15.00	45.00
Subtotal - a, b, and c	\$ 1,51 6. 40		
d. Miscellaneous = 10% x Subtotal 7,518.40 =	751.84		751,84
Total - a, b, c, and d	8,270.24		*****
GRAND TOTALS	\$30,798.24	\$2,573.02	\$28,225.22

Notes:

- (A) Cost of equipment for 4 stations = \$200
- (B) $10 \text{ ops } \times 40 = 400 \times 4,000 = 1,600,000 \text{ annual prod.}$
- (C) $3.52 \times 4,000 = 14,080$
- (D) 4 stations x 30 sq. ft. = 120

Cost per piece = $\frac{$30,798.24}{1,600,000}$ = .0192

This operation is not being performed in the present machine process manufacture, and therefore is not being charged against the projected hand process manufacture.



Processes Module Riser Wire Clipping	Mach.	No	MM-2
Equipment 2 Segment Clippers (A)			
Based on 2 shifts, $3,797$ hrs., hourly prod.	384 and annual	prod.	1,458,000
		Annual C	Cost
	Total	Fixed	<u>Variable</u>
1. Material		xx	
2. Direct Labor = Hrs. 4,000 x Rate 3,20 (B) =	\$12,800	хx	\$12,800
3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 12,800 =	3, 840	\$1,152	2,688
b. Mach., Equip. & Tool	11,600	6, 140	5,460
c. Occupancy = Proc. Space 122 x Ratio 6 = 732 sq.	ft		
Reut 732×1.00 =	732	732	
Light $732 \times .30$	220	22	198
Heat $732 \times .10$ =	<u>73</u>	54	19
Subtotal - a, b, and c	\$16,465	\$8,100	\$ 8,365
d. Miscellaneous = 10% x Subtotal 16,465	1,647	810	837_
Total - a,b,c, and d	18, 112	8,910	9.202
GRAND TOTALS	\$30,912	\$8,910	\$22,002

Notes:

- (A) Two segment clippers @ \$14,500 . \$29,000
- (B) 2 Semi-skilled @ \$1,60 = \$3.20

Cost per piece = $\frac{$30,912}{1,458,000}$ = .0212

PROJECT TINKERTOY -- Manufacturing Cost Data Module Riser Wire Clipping Processes Hand HM - 2. No. Equipment Bench, stools, special cutters (A) Based on 2 shifts, 4,000 hrs., hourly prod. 400 and annual prod. 1,600,000 (B) Annual Cost Total Fixed Variable 1. Material $\mathbf{x}\mathbf{x}$ 2. Direct Labor . Hrs. 27,456 (C) x Rate 1.6 . \$43,929.60 \$43,929.60 ХX 3. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 43,929.60 = 13, 178.88 \$3, 953.66 9,225.22 b. Mach., Equip. & Tool 101.60 82.55 19.05 c. Occupancy = Proc. Space 210 (D) x Ratio 5 = 1,050 sq. ft Rent $1050 \times .8$ 840.00 840.00 Light $1050 \times .3$ 31,50 283.50 315.00 Heat $1050 \times .1$ 26,25 105.00 78.75

\$14,540.48

1, 454.05

15,994.53

\$59,924.13 \$4,986.46

Notes:

d. Miscellaneous -

(A) Equipment for 7 stations . \$894

10% x Subtotal 14,540.48 ..

(B) 10 opers $< 40 \pm 400 \times 4,000 \pm 1,600,000$

Subtotal - a, b, and c

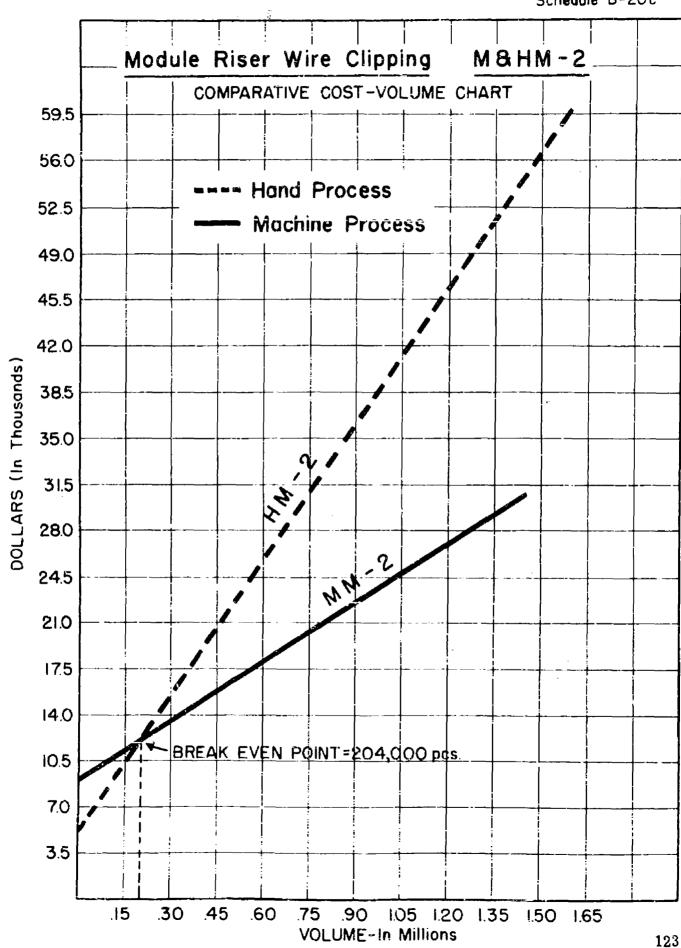
Total - a, b, c, and d

GRAND TOTALS

- (C) 6.864 x 4,000 a 27,456 Dir. Lab. Hrs.
- (D) 7 stations x 30 sq. ft. . 310 sq. ft.

Cost per piece = \$59,924.13 = .0375 1,600,000 1,454.05

\$54,937.67



Processes _	Module Testing	Mach.	No.	MM-3
Equipment	2 Module Testers (A)			
Based on 2 s	hifts, 4000 hrs., hourly prod.	654 and annua	l prod. 1,	458,000
		<u>.</u>	Annual Costs	_
	Item	Total	Fixed	Variable
1. Material			xx	
2. Direct Lal Hrs. 284	bor = 40 x Rate 3.20 (B) =	\$9,088	xx	\$9,088
	ring Overhead ab. = 30% of Dir. 9,088 =	2,726.40	\$ 817.92	1,908.48
b. Mach.	, Equip, & Tool	6,413.00	3,388.00	3,025.00
c. Occupa Proc. Rei Lig Hea	Space 20 x Ratio 6 = 120 sq. ft nt $\frac{120 \times 1.00}{120 \times .30}$ =	120.00 36.00 12.00 9,307.40	120.00 4.00 9.00	32.00 3.00
d. Miscella	ancous =			·
10%	x Subtotal 9, 307.40	930.74		930.74
	Total - a, b, c, and d	10,238.14	**************************************	
	GRAND TOTALS	\$19, 326.14	\$4,338.92	\$14,987.22

Notes:

- (A) 2 Module Testers @ 8,000 . \$16,000
- (B) 2 Semi-skilled @ \$1.60 = \$3.20

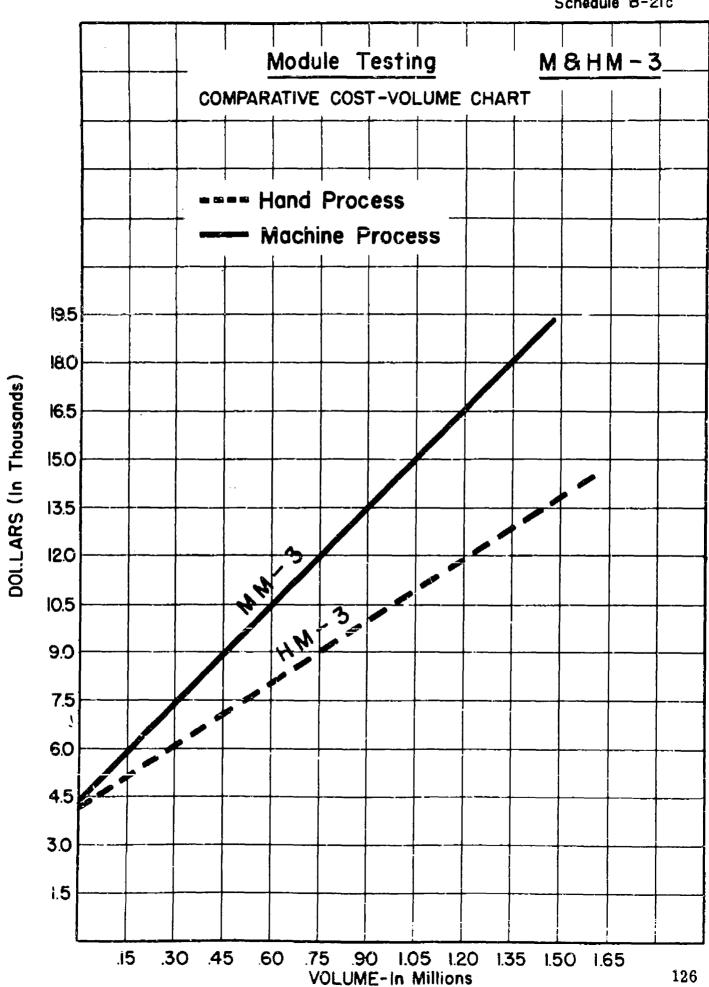
Cost per piece * \$19,326.14 = .01325 1,458,000

Process	Module Testing	Hand	No. H	M-3
Equipment	Bench, Stools & Module Teste	rs (A)		
Based on 2	shifts, 4000 hrs., hourly prod.	400 and annual	prod. 1,600,	000 (B)
		<u>A</u>	nnual Costs	
		Total	Fixed	Variable
1. Material			хх	
2. Direct La Hrs. 4,	abor = ,400(C) x Rate 1.6 =	\$ 7,040.00	xx	\$ <u>7,040.00</u>
	turing Overhead ab. = 30% of Dir. 7,040,00 =	2,112.00	\$ 633.60	1,478.40
b. Mach.	, Equip. & Tool	4,633.75	3, 241, 62	1,390.13
R	ancy = . Space 60(D) x Ratio 5: 300 sq.: ent 300 x .80 = ight 300 x .30 =	ft. 240.00 90.00	2 4 0.00 9.00	81.00
Н	eat 300 x .10 =	30.00	22.50	7.50
	Subtotal - a, b, and c	7, 105. 75		
	llaneous = 0% x Subtotal 7,105.75 Total - a, b, c, and d	710.58 7,816.33		710.58
	GRAND TOTALS	\$14,856.33	\$ 4, 148. 72	\$ 10, 707.61

Notes:

- (A) Equipment for 2 stations = \$18,535
- (B) 10 operations/mod. x 40 mod./hr. = 400 hrly. x 4000 hrs./yr. = 1,600,000 annual production
- (C) 1.10 x 4000 = 4400 Direct Labor Hrs.
- (D) 2 stations = 30 = 60 sq. ft.

Cost per piece = \$14,856.28 = .00928 1,600,000 pcs.



Processes Machine process manufacturing of IF Amplifier Modules

Equipment *See schedule sheets for machine process steps

Based on 2 shifts, 4,000 hrs., and annual production 1,620,000

	.·	Total	Fixed	Variable
**	Standard Machine Processing Costs	\$785, 77 1	\$209,021	\$ 576, 7 50
	Special Hand Operations on Modules #1 and #9	19, 563	1,843	17, 720
	GRAND TOTALS	\$8 05, 334	\$210,864	\$594,470

^{*} For cost of equipment see Exhibit 7.

^{**} Total machine processing costs for 1,620,000 modules annually for IF Amplifiers as shown on pertinent schedule sheets in Appendix B.

Processes Hand process manufacturing of IF Amplifier Modules

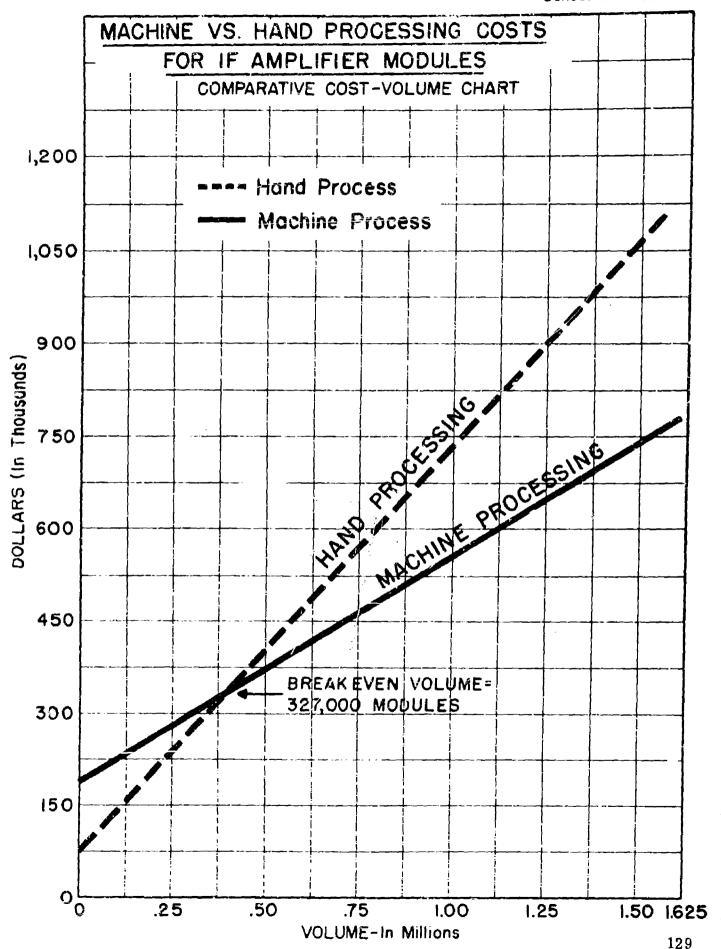
Equipment * See schedule sheets for pertinent hand process steps

Based on 2 shifts, 4,000 hrs., and annual production 1,600,000

	Total	Fixed	Variable
** Standard Hand Processing Costs	\$1,172,959	\$107,652	\$1,065,307
Special Hand Operations on Modules #1 and #9	19, 563	1,843	17,720
GRAND TOTALS	\$1, 192, 522	\$109,495	\$1,083,027

^{*} For cost of equipment see Exhibit 8.

^{**} Total hand processing costs for 1,600,000 modules annually for IF Amplifiers as shown on pertinent schedule sheets in Appendix B1.



APPENDIX C

IF Amplifier Module Cost Data

Schedule	Description
C-1	IF Amplifier Machine Process Module Cost Data
C-2	IF Amplifier Hand Process Module Cost Data

MODULE COBIE
AMPLIPIES
PROCKES IF
AACRIRE
T THERMSOT
PROJEC

Operation Dental Parties Parti	ica	Unit <u>Lobor</u> . 322/0 . 252 . 126	Date Overhead 275/0 .055 .056 .184	70. Labor 024. Labor 1.288 1.008 1.008 1.008	or Overhead 1.10 2.64 1.264 1.264 1.246 2.46 2.46 2.46	70. 1400 70. 1.610 7 1.610 7 1.260 7 1.260	Module 2 box Overhead .610 1.375 .860 1.590 .860 1.590 .930 .630 .720	28 กกกกก	Hadule 3 1.610 1.260 .630	Fo. 11.375 \$ 11.690 5 1.690 5 1.700 5 1.700 5	1.610 1.650 1.260 .630	Drethaed 1.375 330 1.890 310 770	75. Labor 1.610 5 1.260 5 1.260 5 1.260 5 5 1.260 5 5 1.260 5 1.260 5 5 1.260 5 1.	box Coertesd 610 1.375 7.500 1.659 7.500 1.659 630 1.659	SS NOTATE	Mcdule (Lebor Dres 1.610 1. 1,008 1.	7 Crerbead 6 1.375 1.037 1.037 248	Ko, Labor (6-1. Labor (5 1.610 5 1.260 5 .630	7 01.375 1.375 1.250 1.250 1.770	Mo. Modul. 900. 1.610
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13.

APPENDIX D

IF Amplifier Assembly & Test Cost Data

Schedule	Description
D-1	IF Amplifier Assembly & Test Cost Data Sheet
D-2	IF Amplifier Assembly & Test. Production Rates

IF AMPLIFIER ASSEMBLY & TEST COST DATA

rocess IF Amplifier Assembly & Test	Hand		
quipment Benches, stools, fixture & testin	g equipment (4)	
ased on 2 shifts, 4000 hrs., hrly. prod. 40	and annual pro	d. 160,000	
		Annual Cost	
	Total	Fixed	Variable
, Material		×x	·
. Direct Labor = Hrs. 61,600 (B) x Rate 1.6 =	\$98,560.00	жж	\$ 98,560.00
. Manufacturing Overhead a. Ind. Lab. = 30% of Dir. 98,560.00 =	29,568.00	\$ 8,870,00	20,698.00
b. Mach., Equip, & Tool	312, 50	218.75	93.75
c. Occupancy =			
Proc. Space 480 (C) x Ratio $5 = 2,400$ Rent 2400 x . 8		1,920.00	** = *
Light $2400 \times .3$ = Heat $2400 \times .1$ =	720,00 2 4 0,00	72,00 260 00	648. 00 180. 00
Subtotal - a, b, and c	\$32,760,50		
d. Miscellaneous =	÷		
$10\% \times \text{Subtotal} \ 32,760.50 =$	_3,276,05	 .	3,276.05
Total - a,b,c, and d	36,036,55		
GRAND TOTALS	\$134,596,55	\$11,140.75	\$123,455,80

\$134,596,55 = .84 160,000

Cost per piece =

IF AMPLIFIER

Final Assembly and Test Production Rates

0			nated ion Rate
Ор. <u>No.</u>	Operation Description	hrs/pc	pcs/hi
	Bottom Plate Assembly		
FA-1	Insert 10 IF Modules	. 02578	39
FA-2	Insert 8 decoupling shields	. 00992	101
	Top Plate Assembly		
FA-3	Assemble female connector to top plate with eyelets in eyelet machine; solder.	. 01289	78
FA-4	Assemble 9 tube shield clips to top plate with eyelet in eyelet machine and solder each clip.	. 04253	24
FA-5	Assemble tuning coil and 8 inner stage shields to top plate and assemble top plate subassembly to bottom plate.	. 04253	24
r A-fi	Solder 8 inner stage shields to top and bottom plates	107	9
FA 7	Solder all module riser wires and tuning coil connections in spacial fixture.	. 0258	39
FA 8	Assemble 9 tubes, 9 tube shields, transformer shield and coaxial cable; solder.	. 08656	12
	Test		
FA 9	Test: Band pass and gain	. 03222	31
	TOTAL	. 38543	

Armed Services Technical Information Agency

Because of our limited supply, you are requested to return this con VIIN IT HAS SERVED YOUR PURPOSE so that it may be made available to other requesters. Your cooperation will be appreciated.



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